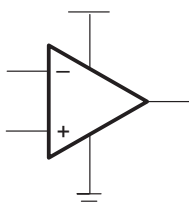


## FAMILY OF WIDE-BANDWIDTH HIGH-OUTPUT-DRIVE SINGLE SUPPLY OPERATIONAL AMPLIFIERS

Check for Samples: [TLC080](#) , [TLC081](#), [TLC082](#), [TLC083](#), [TLC084](#), [TLC085](#), [TLC08xA](#)

### FEATURES

- **Wide Bandwidth:** 10 MHz
- **High Output Drive:**
  - $I_{OH}$ : 57 mA at  $V_{DD} - 1.5$  V
  - $I_{OL}$ : 55 mA at 0.5 V
- **High Slew Rate:**
  - $SR+$ : 16 V/ $\mu$ s
  - $SR-$ : 19 V/ $\mu$ s
- **Wide Supply Range:** 4.5 V to 16 V
- **Supply Current:** 1.9 mA/Channel
- **Ultralow Power Shutdown Mode:**
  - $I_{DD}$ : 125  $\mu$ A/Channel
- **Low Input Noise Voltage:** 8.5 nV/ $\sqrt{\text{Hz}}$
- **Input Offset Voltage:** 60  $\mu$ V
- **Ultra-Small Packages:**
  - 8- or 10-Pin MSOP (TLC080/1/2/3)



### DESCRIPTION

The first members of TI's new BiMOS general-purpose operational amplifier family are the TLC08x. The BiMOS family concept is simple: provide an upgrade path for BiFET users who are moving away from dual-supply to single-supply systems and demand higher ac and dc performance. With performance rated from 4.5 V to 16 V across commercial (0°C to 70°C) and an extended industrial temperature range (–40°C to 125°C), BiMOS suits a wide range of audio, automotive, industrial, and instrumentation applications. Familiar features like offset nulling pins, and new features like MSOP PowerPAD™ packages and shutdown modes, enable higher levels of performance in a variety of applications.

Developed in TI's patented LBC3 BiCMOS process, the new BiMOS amplifiers combine a very high input impedance, low-noise CMOS front end with a high-drive bipolar output stage, thus providing the optimum performance features of both. AC performance improvements over the TL08x BiFET predecessors include a bandwidth of 10 MHz (an increase of 300%) and voltage noise of 8.5 nV/ $\sqrt{\text{Hz}}$  (an improvement of 60%). DC improvements include an ensured  $V_{ICR}$  that includes ground, a factor of 4 reduction in input offset voltage down to 1.5 mV (maximum) in the standard grade, and a power supply rejection improvement of greater than 40 dB to 130 dB. Added to this list of impressive features is the ability to drive  $\pm 50$ -mA loads comfortably from an ultrasmall-footprint MSOP PowerPAD package, which positions the TLC08x as the ideal high-performance general-purpose operational amplifier family.

**FAMILY PACKAGE TABLE**

| DEVICE | NO. OF CHANNELS | PACKAGE TYPES |      |      |       |          | UNIVERSAL EVM BOARD                             |
|--------|-----------------|---------------|------|------|-------|----------|-------------------------------------------------|
|        |                 | MSOP          | PDIP | SOIC | TSSOP | SHUTDOWN |                                                 |
| TLC080 | 1               | 8             | 8    | 8    | —     | Yes      | Refer to the EVM Selection Guide (Lit# SLOU060) |
| TLC081 | 1               | 8             | 8    | 8    | —     | —        |                                                 |
| TLC082 | 2               | 8             | 8    | 8    | —     | —        |                                                 |
| TLC083 | 2               | 10            | 14   | 14   | —     | Yes      |                                                 |
| TLC084 | 4               |               | 14   | 14   | 20    | —        |                                                 |
| TLC085 | 4               |               | 16   | 16   | 20    | Yes      |                                                 |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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### TLC080 and TLC081 AVAILABLE OPTIONS

| $T_A$          | PACKAGED DEVICES                    |                                       |         |                    |
|----------------|-------------------------------------|---------------------------------------|---------|--------------------|
|                | SMALL OUTLINE<br>(D) <sup>(1)</sup> | SMALL OUTLINE<br>(DGN) <sup>(1)</sup> | SYMBOL  | PLASTIC DIP<br>(P) |
| 0°C to 70°C    | TLC080CD                            | TLC080CDGN                            | xxTIACW | TLC080CP           |
|                | TLC081CD                            | TLC081CDGN                            | xxTIACY | TLC081CP           |
| –40°C to 125°C | TLC080ID                            | TLC080IDGN                            | xxTIACX | TLC080IP           |
|                | TLC081ID                            | TLC081IDGN                            | xxTIACZ | TLC081IP           |
|                | TLC080AID                           | —                                     | —       | TLC080AIP          |
|                | TLC081AID                           | —                                     | —       | TLC081AIP          |

(1) This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLC080CDR).

### TLC082 and TLC083 AVAILABLE OPTIONS

| $T_A$          | PACKAGED DEVICES                       |                      |                       |                      |                       |                       |                       |
|----------------|----------------------------------------|----------------------|-----------------------|----------------------|-----------------------|-----------------------|-----------------------|
|                | SMALL<br>OUTLINE<br>(D) <sup>(1)</sup> | MSOP                 |                       |                      |                       | PLASTIC<br>DIP<br>(N) | PLASTIC<br>DIP<br>(P) |
|                |                                        | (DGN) <sup>(1)</sup> | SYMBOL <sup>(2)</sup> | (DGQ) <sup>(1)</sup> | SYMBOL <sup>(2)</sup> |                       |                       |
| 0°C to 70°C    | TLC082CD                               | TLC082CDGN           | xxTIADZ               | —                    | —                     | —                     | TLC082CP              |
|                | TLC083CD                               | —                    | —                     | TLC083CDGQ           | xxTIAEB               | TLC083CN              | —                     |
| –40°C to 125°C | TLC082ID                               | TLC082IDGN           | xxTIAEA               | —                    | —                     | —                     | TLC082IP              |
|                | TLC083ID                               | —                    | —                     | TLC083IDGQ           | xxTIAEC               | TLC083IN              | —                     |
|                | TLC082AID                              | —                    | —                     | —                    | —                     | —                     | TLC082AIP             |
|                | TLC083AID                              | —                    | —                     | —                    | —                     | TLC083AIN             | —                     |

(1) This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLC082CDR).

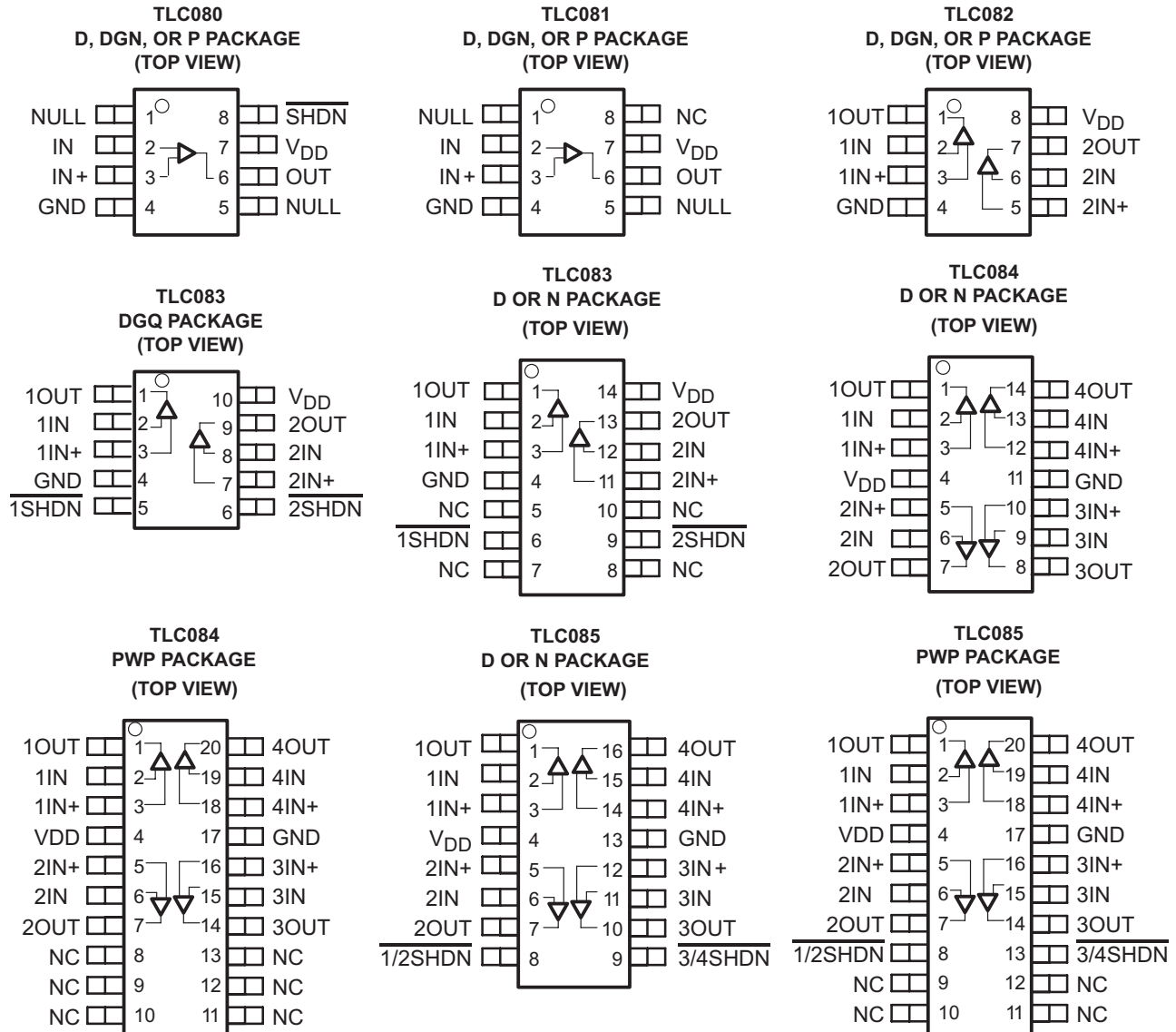
(2) xx represents the device date code.

### TLC084 and TLC085 AVAILABLE OPTIONS

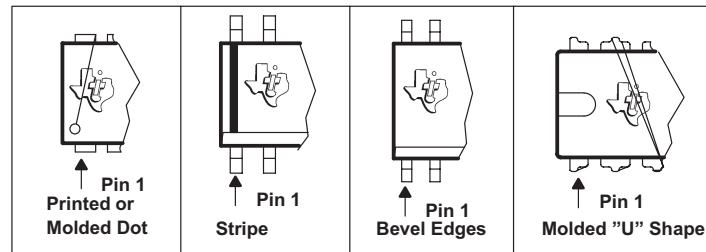
| $T_A$          | PACKAGED DEVICES                    |                    |                               |
|----------------|-------------------------------------|--------------------|-------------------------------|
|                | SMALL OUTLINE<br>(D) <sup>(1)</sup> | PLASTIC DIP<br>(N) | TSSOP<br>(PWP) <sup>(1)</sup> |
| 0°C to 70°C    | TLC084CD                            | TLC084CN           | TLC084CPWP                    |
|                | TLC085CD                            | TLC085CN           | TLC085CPWP                    |
| –40°C to 125°C | TLC084ID                            | TLC084IN           | TLC084IPWP                    |
|                | TLC085ID                            | TLC085IN           | TLC085IPWP                    |
|                | TLC084AID                           | TLC084AIN          | TLC084AIPWP                   |
|                | TLC085AID                           | TLC085AIN          | TLC085AIPWP                   |

(1) This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLC084CDR).

For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or see the TI web site at [www.ti.com](http://www.ti.com).



NC - No internal connection

**TYPICAL PIN 1 INDICATORS**


## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                              | VALUE                        | UNIT       |
|--------------------------------------------------------------|------------------------------|------------|
| Supply voltage, $V_{DD}$ <sup>(2)</sup>                      | 17                           | V          |
| Differential input voltage range, $V_{ID}$                   | $\pm V_{DD}$                 |            |
| Continuous total power dissipation                           | See Dissipation Rating Table |            |
| Operating free-air temperature range, $T_A$ :                | C suffix                     | 0 to 70    |
|                                                              | I suffix                     | –40 to 125 |
| Maximum junction temperature, $T_J$                          | 150                          | °C         |
| Storage temperature range, $T_{stg}$                         | –65 to 150                   | °C         |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260                          | °C         |

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential voltages, are with respect to GND .

## DISSIPATION RATING TABLE

| PACKAGE    | $\theta_{JC}$<br>(°C/W) | $\theta_{JA}$<br>(°C/W) | $T_A \leq 25^\circ\text{C}$<br>POWER RATING |
|------------|-------------------------|-------------------------|---------------------------------------------|
| D (8)      | 38.3                    | 176                     | 710 mW                                      |
| D (14)     | 26.9                    | 122.3                   | 1022 mW                                     |
| D (16)     | 25.7                    | 114.7                   | 1090 mW                                     |
| DGN (8)    | 4.7                     | 52.7                    | 2.37 W                                      |
| DGQ (10)   | 4.7                     | 52.3                    | 2.39 W                                      |
| N (14, 16) | 32                      | 78                      | 1600 mW                                     |
| P (8)      | 41                      | 104                     | 1200 mW                                     |
| PWP (20)   | 1.40                    | 26.1                    | 4.79 W                                      |

## RECOMMENDED OPERATING CONDITIONS

|                                              |               | MIN        | MAX        | UNIT |
|----------------------------------------------|---------------|------------|------------|------|
| Supply voltage, $V_{DD}$                     | Single supply | 4.5        | 16         | V    |
|                                              | Split supply  | $\pm 2.25$ | $\pm 8$    |      |
| Common-mode input voltage, $V_{ICR}$         |               | GND        | $V_{DD}-2$ | V    |
| Shutdown on/off voltage level <sup>(1)</sup> | $V_{IH}$      | 2          |            | V    |
|                                              | $V_{IL}$      |            | 0.8        |      |
| Operating free-air temperature, $T_A$        | C-suffix      | 0          | 70         | °C   |
|                                              | I-suffix      | –40        | 125        |      |

- (1) Relative to the voltage on the GND terminal of the device.

## ELECTRICAL CHARACTERISTICS

at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)

| PARAMETER                                                                  | TEST CONDITIONS                                                                                      |                          | TA <sup>(1)</sup> | MIN      | TYP      | MAX  | UNIT                         |
|----------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|--------------------------|-------------------|----------|----------|------|------------------------------|
| $V_{IO}$ Input offset voltage                                              | $V_{DD} = 5\text{ V}$ ,<br>$V_{IC} = 2.5\text{ V}$ ,<br>$V_O = 2.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC080/1/2/3,            | 25°C              |          | 390      | 1900 | $\mu\text{V}$                |
|                                                                            |                                                                                                      | TLC084/5                 | Full range        |          |          | 3000 |                              |
|                                                                            |                                                                                                      | TLC080/1/2/3A,           | 25°C              |          | 390      | 1400 |                              |
|                                                                            |                                                                                                      | TLC084/5A                | Full range        |          |          | 2000 |                              |
| $\alpha V_{IO}$ Temperature coefficient of input offset voltage            | $R_S = 50\ \Omega$                                                                                   |                          |                   |          | 1.2      |      | $\mu\text{V}/^\circ\text{C}$ |
| $I_{IO}$ Input offset current                                              | $V_{DD} = 5\text{ V}$ ,<br>$V_{IC} = 2.5\text{ V}$ ,<br>$V_O = 2.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC08XC                  | 25°C              |          | 1.9      | 50   | $\text{pA}$                  |
|                                                                            |                                                                                                      | TLC08XI                  | Full range        |          |          | 100  |                              |
| $I_{IB}$ Input bias current                                                | $V_{DD} = 5\text{ V}$ ,<br>$V_{IC} = 2.5\text{ V}$ ,<br>$V_O = 2.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC08XC                  | 25°C              |          | 3        | 50   | $\text{pA}$                  |
|                                                                            |                                                                                                      | TLC08XI                  | Full range        |          |          | 700  |                              |
| $V_{ICR}$ Common-mode input voltage                                        | $R_S = 50\ \Omega$                                                                                   |                          | 25°C              | 0 to 3.0 | 0 to 3.5 |      | $\text{V}$                   |
|                                                                            |                                                                                                      |                          | Full range        | 0 to 3.0 | 0 to 3.5 |      |                              |
| $V_{OH}$ High-level output voltage                                         | $V_{IC} = 2.5\text{ V}$                                                                              | $I_{OH} = -1\text{ mA}$  | 25°C              | 4.1      | 4.3      |      | $\text{V}$                   |
|                                                                            |                                                                                                      |                          | Full range        | 3.9      |          |      |                              |
|                                                                            |                                                                                                      | $I_{OH} = -20\text{ mA}$ | 25°C              | 3.7      | 4        |      |                              |
|                                                                            |                                                                                                      |                          | Full range        | 3.5      |          |      |                              |
|                                                                            |                                                                                                      | $I_{OH} = -35\text{ mA}$ | 25°C              | 3.4      | 3.8      |      |                              |
|                                                                            |                                                                                                      |                          | Full range        | 3.2      |          |      |                              |
|                                                                            |                                                                                                      | $I_{OH} = -50\text{ mA}$ | 25°C              | 3.2      | 3.6      |      |                              |
|                                                                            |                                                                                                      |                          | -40°C to 85°C     | 3        |          |      |                              |
| $V_{OL}$ Low-level output voltage                                          | $V_{IC} = 2.5\text{ V}$                                                                              | $I_{OL} = 1\text{ mA}$   | 25°C              |          | 0.18     | 0.25 | $\text{V}$                   |
|                                                                            |                                                                                                      |                          | Full range        |          |          | 0.35 |                              |
|                                                                            |                                                                                                      | $I_{OL} = 20\text{ mA}$  | 25°C              |          | 0.35     | 0.39 |                              |
|                                                                            |                                                                                                      |                          | Full range        |          |          | 0.45 |                              |
|                                                                            |                                                                                                      | $I_{OL} = 35\text{ mA}$  | 25°C              |          | 0.43     | 0.55 |                              |
|                                                                            |                                                                                                      |                          | Full range        |          |          | 0.7  |                              |
|                                                                            |                                                                                                      | $I_{OL} = 50\text{ mA}$  | 25°C              |          | 0.45     | 0.63 |                              |
|                                                                            |                                                                                                      |                          | -40°C to 85°C     |          |          | 0.7  |                              |
| $I_{OS}$ Short-circuit output current                                      | Sourcing                                                                                             |                          | 25°C              |          | 100      |      | $\text{mA}$                  |
|                                                                            | Sinking                                                                                              |                          | 25°C              |          | 100      |      |                              |
| $I_O$ Output current                                                       | $V_{OH} = 1.5\text{ V}$ from positive rail                                                           |                          | 25°C              |          | 57       |      | $\text{mA}$                  |
|                                                                            | $V_{OL} = 0.5\text{ V}$ from negative rail                                                           |                          | 25°C              |          | 55       |      |                              |
| $A_{VD}$ Large-signal differential voltage amplification                   | $V_{O(PP)} = 3\text{ V}$ ,<br>$R_L = 10\text{ k}\Omega$                                              |                          | 25°C              | 100      | 120      |      | $\text{dB}$                  |
|                                                                            |                                                                                                      |                          | Full range        | 100      |          |      |                              |
| $r_{i(d)}$ Differential input resistance                                   |                                                                                                      |                          | 25°C              |          | 1000     |      | $\text{G}\Omega$             |
| $C_{IC}$ Common-mode input capacitance                                     | $f = 10\text{ kHz}$                                                                                  |                          | 25°C              |          | 22.9     |      | $\text{pF}$                  |
| $z_o$ Closed-loop output impedance                                         | $f = 10\text{ kHz}$ ,<br>$A_V = 10$                                                                  |                          | 25°C              |          | 0.25     |      | $\Omega$                     |
| CMRR Common-mode rejection ratio                                           | $V_{IC} = 0\text{ to }3\text{ V}$ ,<br>$R_S = 50\ \Omega$                                            |                          | 25°C              | 80       | 110      |      | $\text{dB}$                  |
|                                                                            |                                                                                                      |                          | Full range        | 80       |          |      |                              |
| $k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ ) | $V_{DD} = 4.5\text{ V to }16\text{ V}$ ,<br>$V_{IC} = V_{DD}/2$ ,<br>No load                         |                          | 25°C              | 80       | 100      |      | $\text{dB}$                  |
|                                                                            |                                                                                                      |                          | Full range        | 80       |          |      |                              |

(1) Full range is 0°C to 70°C for C suffix and -40°C to 125°C for I suffix. If not specified, full range is -40°C to 125°C.

## ELECTRICAL CHARACTERISTICS (continued)

at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)

| PARAMETER                                                                             | TEST CONDITIONS                     | $T_A^{(1)}$ | MIN | TYP | MAX | UNIT          |
|---------------------------------------------------------------------------------------|-------------------------------------|-------------|-----|-----|-----|---------------|
| $I_{DD}$ Supply current (per channel)                                                 | $V_O = 2.5\text{ V}$ , No load      | 25°C        |     | 1.8 | 2.5 | mA            |
|                                                                                       |                                     | Full range  |     |     | 3.5 |               |
| $I_{DD(SHDN)}$ Supply current in shutdown mode (per channel) (TLC080, TLC083, TLC085) | $\overline{SHDN} \leq 0.8\text{ V}$ | 25°C        |     | 125 | 200 | $\mu\text{A}$ |
|                                                                                       |                                     | Full range  |     |     | 250 |               |

## OPERATING CHARACTERISTICS

at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)

| PARAMETER          |                                       | TEST CONDITIONS                                                                                  |                        | T <sub>A</sub> <sup>(1)</sup> | MIN  | TYP   | MAX | UNIT    |
|--------------------|---------------------------------------|--------------------------------------------------------------------------------------------------|------------------------|-------------------------------|------|-------|-----|---------|
| SR+                | Positive slew rate at unity gain      | V <sub>O(PP)</sub> = 0.8 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ                       |                        | 25°C                          | 10   | 16    |     | V/μs    |
|                    |                                       |                                                                                                  |                        | Full range                    | 9.5  |       |     |         |
| SR−                | Negative slew rate at unity gain      | V <sub>O(PP)</sub> = 0.8 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ                       |                        | 25°C                          | 12.5 | 19    |     | V/μs    |
|                    |                                       |                                                                                                  |                        | Full range                    | 10   |       |     |         |
| V <sub>n</sub>     | Equivalent input noise voltage        | f = 100 Hz                                                                                       |                        | 25°C                          |      | 12    |     | nV/√Hz  |
|                    |                                       | f = 1 kHz                                                                                        |                        | 25°C                          |      | 8.5   |     |         |
| I <sub>n</sub>     | Equivalent input noise current        | f = 1 kHz                                                                                        |                        | 25°C                          |      | 0.6   |     | fA /√Hz |
| THD + N            | Total harmonic distortion plus noise  | V <sub>O(PP)</sub> = 3 V, R <sub>L</sub> = 10 kΩ and 250 Ω, f = 1 kHz                            | A <sub>V</sub> = 1     | 25°C                          |      | 0.002 |     | %       |
|                    |                                       |                                                                                                  | A <sub>V</sub> = 10    |                               |      | 0.012 |     |         |
|                    |                                       |                                                                                                  | A <sub>V</sub> = 100   |                               |      | 0.085 |     |         |
| t <sub>(on)</sub>  | Amplifier turnon time <sup>(2)</sup>  | R <sub>L</sub> = 10 kΩ                                                                           |                        | 25°C                          |      | 0.15  |     | μs      |
| t <sub>(off)</sub> | Amplifier turnoff time <sup>(2)</sup> |                                                                                                  |                        | 25°C                          |      | 1.3   |     | μs      |
|                    | Gain-bandwidth product                | f = 10 kHz,                                                                                      | R <sub>L</sub> = 10 kΩ | 25°C                          |      | 10    |     | MHz     |
| t <sub>s</sub>     | Settling time                         | V <sub>(STEP)PP</sub> = 1 V, A <sub>V</sub> = −1, C <sub>L</sub> = 10 pF, R <sub>L</sub> = 10 kΩ | 0.1%                   | 25°C                          |      | 0.18  |     | μs      |
|                    |                                       |                                                                                                  | 0.01%                  |                               |      | 0.39  |     |         |
|                    |                                       | V <sub>(STEP)PP</sub> = 1 V, A <sub>V</sub> = −1, C <sub>L</sub> = 47 pF, R <sub>L</sub> = 10 kΩ | 0.1%                   |                               |      | 0.18  |     |         |
|                    |                                       |                                                                                                  | 0.01%                  |                               |      | 0.39  |     |         |
| Φ <sub>m</sub>     | Phase margin                          | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 50 pF | 25°C                          |      | 32    |     | °       |
|                    |                                       | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 0 pF  |                               |      | 40    |     |         |
|                    | Gain margin                           | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 50 pF | 25°C                          |      | 2.2   |     | dB      |
|                    |                                       | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 0 pF  |                               |      | 3.3   |     |         |

(1) Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix. If not specified, full range is –40°C to 125°C.

(2) Disable time and enable time are defined as the interval between application of the logic signal to SHDN and the point at which the supply current has reached half its final value.

## ELECTRICAL CHARACTERISTICS

at specified free-air temperature,  $V_{DD} = 12\text{ V}$  (unless otherwise noted)

| PARAMETER                                                                  | TEST CONDITIONS                                                                                   |                          | TA <sup>(1)</sup> | MIN       | TYP       | MAX  | UNIT                         |
|----------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------------|-------------------|-----------|-----------|------|------------------------------|
| $V_{IO}$ Input offset voltage                                              | $V_{DD} = 12\text{ V}$ ,<br>$V_{IC} = 6\text{ V}$ ,<br>$V_O = 6\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC080/1/2/3,            | 25°C              |           | 390       | 1900 | $\mu\text{V}$                |
|                                                                            |                                                                                                   | TLC084/5                 | Full range        |           |           | 3000 |                              |
|                                                                            |                                                                                                   | TLC080/1/2/3A,           | 25°C              |           | 390       | 1400 |                              |
|                                                                            |                                                                                                   | TLC084/5A                | Full range        |           |           | 2000 |                              |
| $\alpha V_{IO}$ Temperature coefficient of input offset voltage            | $R_S = 50\ \Omega$                                                                                |                          |                   |           | 1.2       |      | $\mu\text{V}/^\circ\text{C}$ |
| $I_{IO}$ Input offset current                                              | $V_{DD} = 12\text{ V}$ ,<br>$V_{IC} = 6\text{ V}$ ,<br>$V_O = 6\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC08xC                  | 25°C              |           | 1.5       | 50   | $\text{pA}$                  |
|                                                                            |                                                                                                   | TLC08xI                  | Full range        |           |           | 100  |                              |
| $I_{IB}$ Input bias current                                                | $V_{DD} = 12\text{ V}$ ,<br>$V_{IC} = 6\text{ V}$ ,<br>$V_O = 6\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLC08xC                  | 25°C              |           | 3         | 50   | $\text{pA}$                  |
|                                                                            |                                                                                                   | TLC08xI                  | Full range        |           |           | 700  |                              |
| $V_{ICR}$ Common-mode input voltage                                        | $R_S = 50\ \Omega$                                                                                |                          | 25°C              | 0 to 10.0 | 0 to 10.5 |      | $\text{V}$                   |
|                                                                            |                                                                                                   |                          | Full range        | 0 to 10.0 | 0 to 10.5 |      |                              |
| $V_{OH}$ High-level output voltage                                         | $V_{IC} = 6\text{ V}$                                                                             | $I_{OH} = -1\text{ mA}$  | 25°C              | 11.1      | 11.2      |      | $\text{V}$                   |
|                                                                            |                                                                                                   |                          | Full range        | 11        |           |      |                              |
|                                                                            |                                                                                                   | $I_{OH} = -20\text{ mA}$ | 25°C              | 10.8      | 11        |      |                              |
|                                                                            |                                                                                                   |                          | Full range        | 10.7      |           |      |                              |
|                                                                            |                                                                                                   | $I_{OH} = -35\text{ mA}$ | 25°C              | 10.6      | 10.7      |      |                              |
|                                                                            |                                                                                                   |                          | Full range        | 10.3      |           |      |                              |
|                                                                            |                                                                                                   | $I_{OH} = -50\text{ mA}$ | 25°C              | 10.3      | 10.5      |      |                              |
|                                                                            |                                                                                                   |                          | -40°C to 85°C     | 10.2      |           |      |                              |
| $V_{OL}$ Low-level output voltage                                          | $V_{IC} = 6\text{ V}$                                                                             | $I_{OL} = 1\text{ mA}$   | 25°C              |           | 0.17      | 0.25 | $\text{V}$                   |
|                                                                            |                                                                                                   |                          | Full range        |           |           | 0.35 |                              |
|                                                                            |                                                                                                   | $I_{OL} = 20\text{ mA}$  | 25°C              |           | 0.35      | 0.45 |                              |
|                                                                            |                                                                                                   |                          | Full range        |           |           | 0.5  |                              |
|                                                                            |                                                                                                   | $I_{OL} = 35\text{ mA}$  | 25°C              |           | 0.4       | 0.52 |                              |
|                                                                            |                                                                                                   |                          | Full range        |           |           | 0.6  |                              |
|                                                                            |                                                                                                   | $I_{OL} = 50\text{ mA}$  | 25°C              |           | 0.45      | 0.6  |                              |
|                                                                            |                                                                                                   |                          | -40°C to 85°C     |           |           | 0.65 |                              |
| $I_{OS}$ Short-circuit output current                                      | Sourcing                                                                                          |                          | 25°C              |           | 150       |      | $\text{mA}$                  |
|                                                                            | Sinking                                                                                           |                          | 25°C              |           | 150       |      |                              |
| $I_O$ Output current                                                       | $V_{OH} = 1.5\text{ V}$ from positive rail                                                        |                          | 25°C              |           | 57        |      | $\text{mA}$                  |
|                                                                            | $V_{OL} = 0.5\text{ V}$ from negative rail                                                        |                          | 25°C              |           | 55        |      |                              |
| $A_{VD}$ Large-signal differential voltage amplification                   | $V_{O(PP)} = 8\text{ V}$ ,<br>$R_L = 10\text{ k}\Omega$                                           |                          | 25°C              | 120       | 140       |      | $\text{dB}$                  |
|                                                                            |                                                                                                   |                          | Full range        | 120       |           |      |                              |
| $r_{i(d)}$ Differential input resistance                                   |                                                                                                   |                          | 25°C              |           | 1000      |      | $\text{G}\Omega$             |
| $C_{IC}$ Common-mode input capacitance                                     | $f = 10\text{ kHz}$                                                                               |                          | 25°C              |           | 21.6      |      | $\text{pF}$                  |
| $z_o$ Closed-loop output impedance                                         | $f = 10\text{ kHz}$ ,<br>$A_V = 10$                                                               |                          | 25°C              |           | 0.25      |      | $\Omega$                     |
| CMRR Common-mode rejection ratio                                           | $V_{IC} = 0\text{ to }10\text{ V}$ ,<br>$R_S = 50\ \Omega$                                        |                          | 25°C              | 80        | 110       |      | $\text{dB}$                  |
|                                                                            |                                                                                                   |                          | Full range        | 80        |           |      |                              |
| $k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ ) | $V_{DD} = 4.5\text{ V to }16\text{ V}$ ,<br>$V_{IC} = V_{DD}/2$ ,<br>No load                      |                          | 25°C              | 80        | 100       |      | $\text{dB}$                  |
|                                                                            |                                                                                                   |                          | Full range        | 80        |           |      |                              |

(1) Full range is 0°C to 70°C for C suffix and -40°C to 125°C for I suffix. If not specified, full range is -40°C to 125°C.

## ELECTRICAL CHARACTERISTICS (continued)

at specified free-air temperature,  $V_{DD} = 12\text{ V}$  (unless otherwise noted)

| PARAMETER                                                                             | TEST CONDITIONS                     | $T_A^{(1)}$ | MIN | TYP | MAX | UNIT          |
|---------------------------------------------------------------------------------------|-------------------------------------|-------------|-----|-----|-----|---------------|
| $I_{DD}$ Supply current (per channel)                                                 | $V_O = 7.5\text{ V}$ , No load      | 25°C        |     | 1.9 | 2.9 | mA            |
|                                                                                       |                                     | Full range  |     |     | 3.5 |               |
| $I_{DD(SHDN)}$ Supply current in shutdown mode (TLC080, TLC083, TLC085) (per channel) | $\overline{SHDN} \leq 0.8\text{ V}$ | 25°C        |     | 125 | 200 | $\mu\text{A}$ |
|                                                                                       |                                     | Full range  |     |     | 250 |               |

## OPERATING CHARACTERISTICS

at specified free-air temperature,  $V_{DD} = 12\text{ V}$  (unless otherwise noted)

| PARAMETER          |                                       | TEST CONDITIONS                                                                                  |                        | T <sub>A</sub> <sup>(1)</sup> | MIN  | TYP   | MAX | UNIT    |
|--------------------|---------------------------------------|--------------------------------------------------------------------------------------------------|------------------------|-------------------------------|------|-------|-----|---------|
| SR+                | Positive slew rate at unity gain      | V <sub>O(PP)</sub> = 2 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ                         |                        | 25°C                          | 10   | 16    |     | V/μs    |
|                    |                                       |                                                                                                  |                        | Full range                    | 9.5  |       |     |         |
| SR−                | Negative slew rate at unity gain      | V <sub>O(PP)</sub> = 2 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ                         |                        | 25°C                          | 12.5 | 19    |     | V/μs    |
|                    |                                       |                                                                                                  |                        | Full range                    | 10   |       |     |         |
| V <sub>n</sub>     | Equivalent input noise voltage        | f = 100 Hz                                                                                       |                        | 25°C                          |      | 14    |     | nV/√Hz  |
|                    |                                       | f = 1 kHz                                                                                        |                        | 25°C                          |      | 8.5   |     |         |
| I <sub>n</sub>     | Equivalent input noise current        | f = 1 kHz                                                                                        |                        | 25°C                          |      | 0.6   |     | fA /√Hz |
| THD + N            | Total harmonic distortion plus noise  | V <sub>O(PP)</sub> = 8 V, R <sub>L</sub> = 10 kΩ and 250 Ω, f = 1 kHz                            | A <sub>V</sub> = 1     | 25°C                          |      | 0.002 |     | %       |
|                    |                                       |                                                                                                  | A <sub>V</sub> = 10    |                               |      | 0.005 |     |         |
|                    |                                       |                                                                                                  | A <sub>V</sub> = 100   |                               |      | 0.022 |     |         |
| t <sub>(on)</sub>  | Amplifier turnon time <sup>(2)</sup>  | R <sub>L</sub> = 10 kΩ                                                                           |                        | 25°C                          |      | 0.47  |     | μs      |
| t <sub>(off)</sub> | Amplifier turnoff time <sup>(2)</sup> |                                                                                                  |                        | 25°C                          |      | 2.5   |     | μs      |
|                    | Gain-bandwidth product                | f = 10 kHz,                                                                                      | R <sub>L</sub> = 10 kΩ | 25°C                          |      | 10    |     | MHz     |
| t <sub>s</sub>     | Settling time                         | V <sub>(STEP)PP</sub> = 1 V, A <sub>V</sub> = −1, C <sub>L</sub> = 10 pF, R <sub>L</sub> = 10 kΩ | 0.1%                   | 25°C                          |      | 0.17  |     | μs      |
|                    |                                       |                                                                                                  | 0.01%                  |                               |      | 0.22  |     |         |
|                    |                                       | V <sub>(STEP)PP</sub> = 1 V, A <sub>V</sub> = −1, C <sub>L</sub> = 47 pF, R <sub>L</sub> = 10 kΩ | 0.1%                   |                               |      | 0.17  |     |         |
|                    |                                       |                                                                                                  | 0.01%                  |                               |      | 0.29  |     |         |
| Φ <sub>m</sub>     | Phase margin                          | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 50 pF | 25°C                          |      | 37    |     | °       |
|                    |                                       | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 0 pF  |                               |      | 42    |     |         |
|                    | Gain margin                           | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 50 pF | 25°C                          |      | 3.1   |     | dB      |
|                    |                                       | R <sub>L</sub> = 10 kΩ,                                                                          | C <sub>L</sub> = 0 pF  |                               |      | 4     |     |         |

(1) Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix. If not specified, full range is –40°C to 125°C.

(2) Disable time and enable time are defined as the interval between application of the logic signal to SHDN and the point at which the supply current has reached half its final value.

## TYPICAL CHARACTERISTICS

**Table of Graphs**

|             |                                       |                                              | <b>FIGURE</b> |
|-------------|---------------------------------------|----------------------------------------------|---------------|
| $V_{IO}$    | Input offset voltage                  | vs Common-mode input voltage                 | 1, 2          |
| $I_{IO}$    | Input offset current                  | vs Free-air temperature                      | 3, 4          |
| $I_{IB}$    | Input bias current                    | vs Free-air temperature                      | 3, 4          |
| $V_{OH}$    | High-level output voltage             | vs High-level output current                 | 5, 7          |
| $V_{OL}$    | Low-level output voltage              | vs Low-level output current                  | 6, 8          |
| $Z_o$       | Output impedance                      | vs Frequency                                 | 9             |
| $I_{DD}$    | Supply current                        | vs Supply voltage                            | 10            |
| PSRR        | Power supply rejection ratio          | vs Frequency                                 | 11            |
| CMRR        | Common-mode rejection ratio           | vs Frequency                                 | 12            |
| $V_n$       | Equivalent input noise voltage        | vs Frequency                                 | 13            |
| $V_{O(PP)}$ | Peak-to-peak output voltage           | vs Frequency                                 | 14, 15        |
|             | Crosstalk                             | vs Frequency                                 | 16            |
|             | Differential voltage gain             | vs Frequency                                 | 17, 18        |
|             | Phase                                 | vs Frequency                                 | 17, 18        |
| $\Phi_m$    | Phase margin                          | vs Load capacitance                          | 19, 20        |
|             | Gain margin                           | vs Load capacitance                          | 21, 22        |
|             | Gain-bandwidth product                | vs Supply voltage                            | 23            |
| SR          | Slew rate                             | vs Supply voltage<br>vs Free-air temperature | 24<br>25, 26  |
| THD + N     | Total harmonic distortion plus noise  | vs Frequency                                 | 27, 28        |
|             |                                       | vs Peak-to-peak output voltage               | 29, 30        |
|             | Large-signal follower pulse response  |                                              | 31, 32        |
|             | Small-signal follower pulse response  |                                              | 33            |
|             | Large-signal inverting pulse response |                                              | 34, 35        |
|             | Small-signal inverting pulse response |                                              | 36            |
|             | Shutdown forward isolation            | vs Frequency                                 | 37, 38        |
|             | Shutdown reverse isolation            | vs Frequency                                 | 39, 40        |
|             | Shutdown supply current               | vs Supply voltage                            | 41            |
|             |                                       | vs Free-air temperature                      | 42            |
|             | Shutdown pulse                        |                                              | 43, 44        |

## TYPICAL CHARACTERISTICS

INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT VOLTAGE

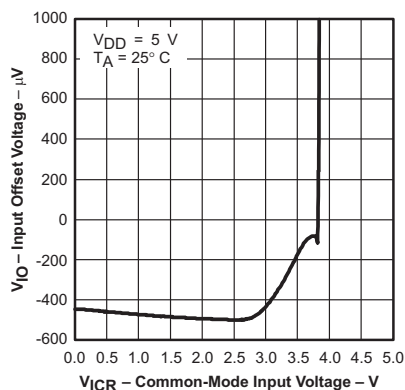


Figure 1.

INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT VOLTAGE

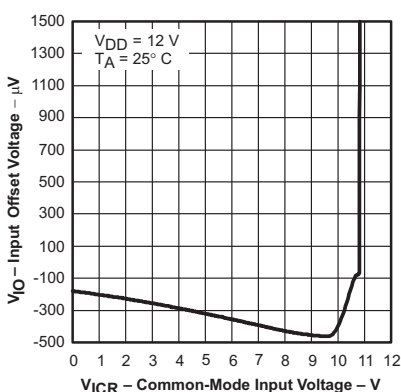


Figure 2.

INPUT BIAS CURRENT AND  
INPUT OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE

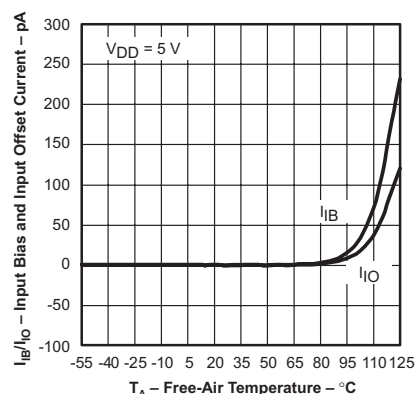


Figure 3.

INPUT BIAS CURRENT AND  
INPUT OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE

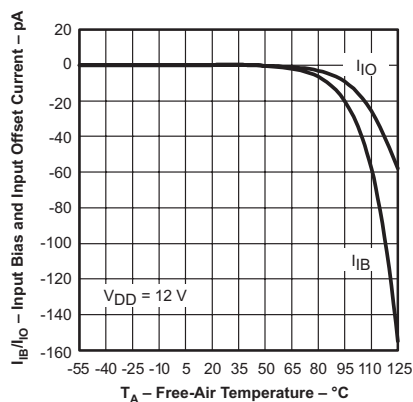


Figure 4.

HIGH-LEVEL OUTPUT VOLTAGE  
vs  
HIGH-LEVEL OUTPUT CURRENT

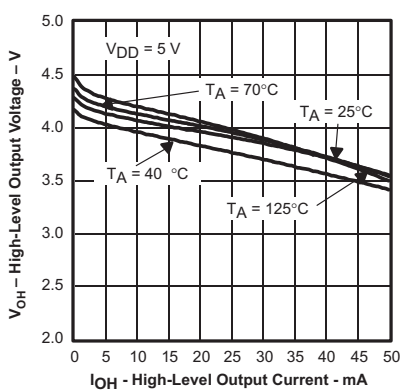


Figure 5.

LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT

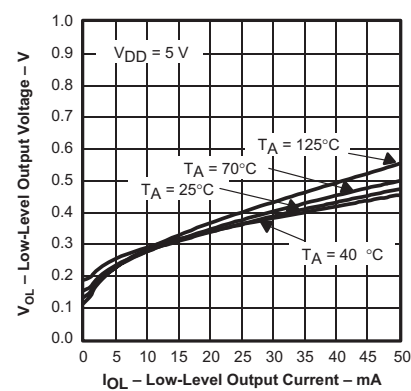


Figure 6.

HIGH-LEVEL OUTPUT VOLTAGE  
vs  
HIGH-LEVEL OUTPUT CURRENT

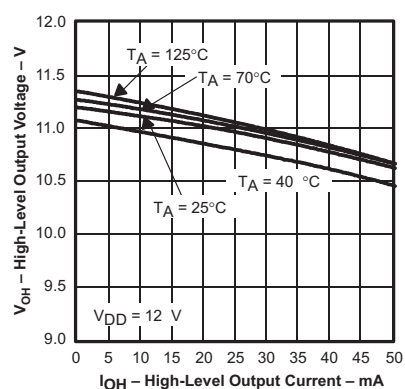


Figure 7.

LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT

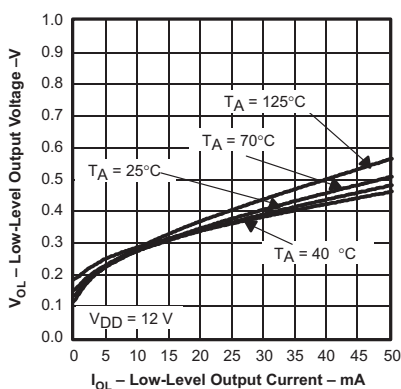


Figure 8.

OUTPUT IMPEDANCE  
vs  
FREQUENCY

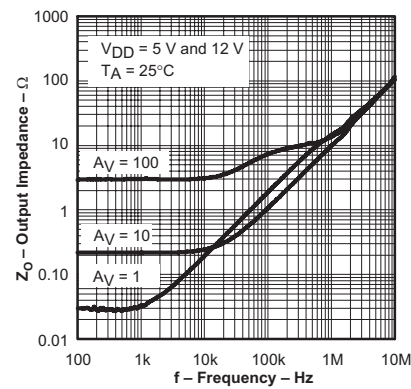


Figure 9.

## TYPICAL CHARACTERISTICS

**SUPPLY CURRENT  
VS  
SUPPLY VOLTAGE**

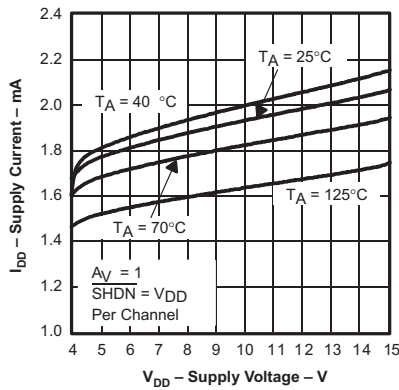


Figure 10.

**POWER SUPPLY REJECTION  
RATIO  
VS  
FREQUENCY**

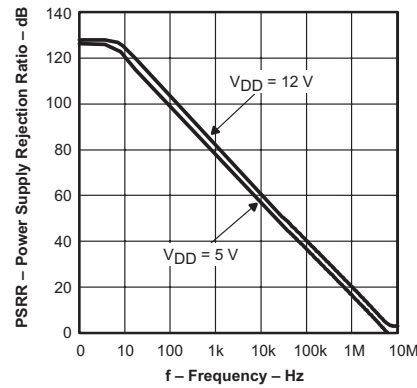


Figure 11.

**COMMON-MODE REJECTION RATIO  
VS  
FREQUENCY**

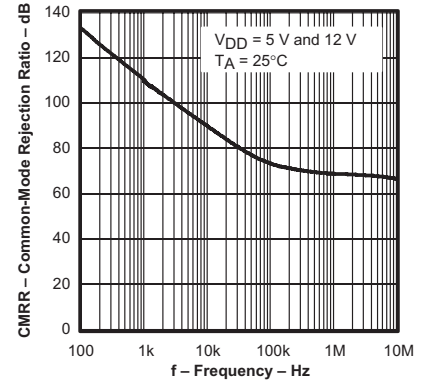


Figure 12.

**EQUIVALENT INPUT NOISE  
VOLTAGE  
VS  
FREQUENCY**

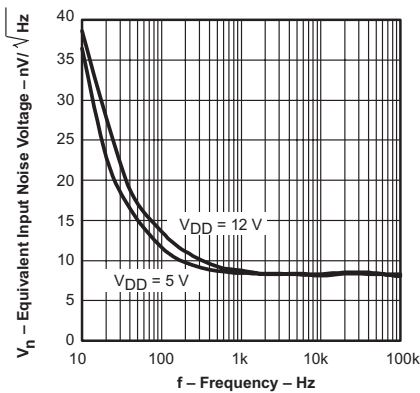


Figure 13.

**PEAK-TO-PEAK OUTPUT  
VOLTAGE  
VS  
FREQUENCY**

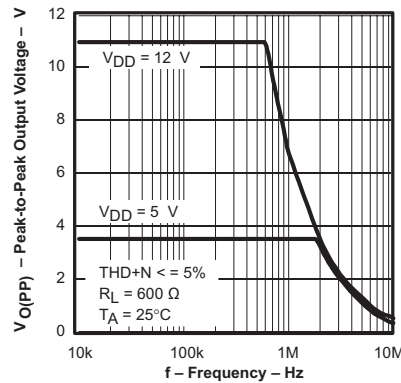


Figure 14.

**PEAK-TO-PEAK OUTPUT  
VOLTAGE  
VS  
FREQUENCY**

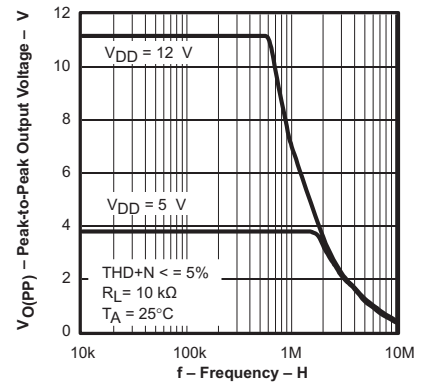


Figure 15.

**CROSSTALK  
VS  
FREQUENCY**

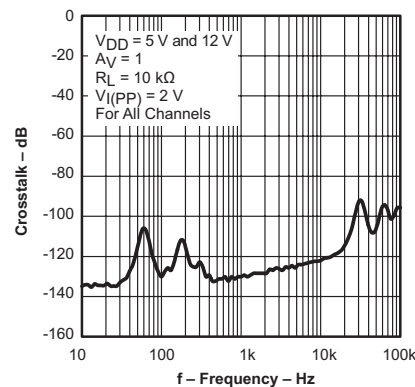


Figure 16.

## TYPICAL CHARACTERISTICS

**DIFFERENTIAL VOLTAGE GAIN AND  
PHASE  
VS  
FREQUENCY**

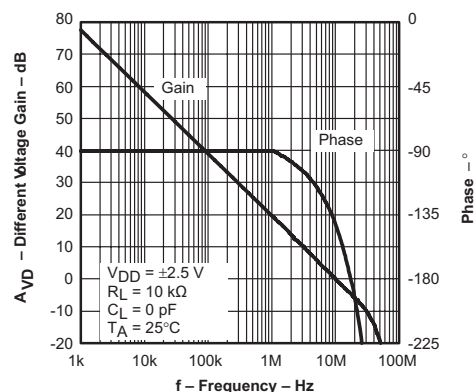


Figure 17.

**DIFFERENTIAL VOLTAGE GAIN AND  
PHASE  
VS  
FREQUENCY**

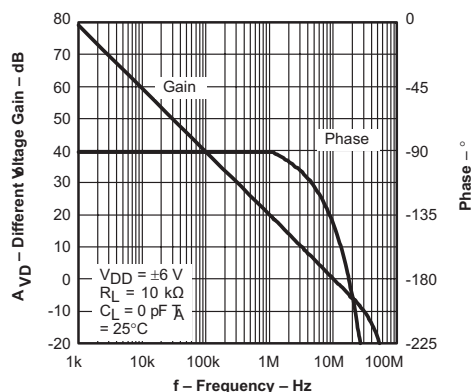


Figure 18.

**PHASE MARGIN  
VS  
LOAD CAPACITANCE**

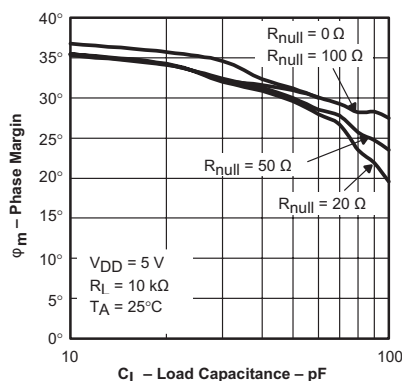


Figure 19.

**PHASE MARGIN  
VS  
LOAD CAPACITANCE**

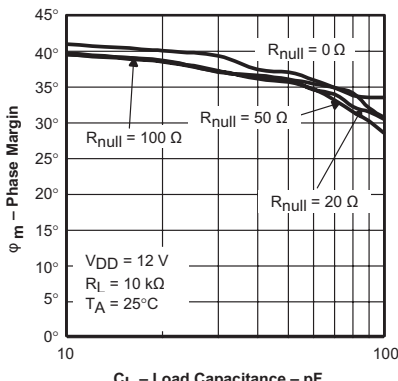


Figure 20.

**GAIN MARGIN  
VS  
LOAD CAPACITANCE**

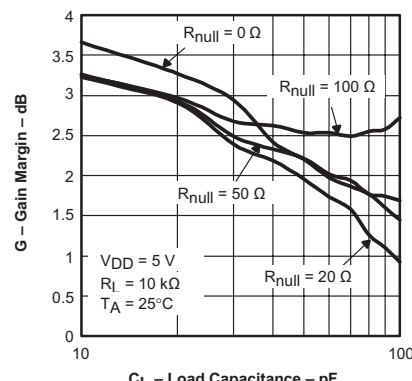


Figure 21.

**GAIN MARGIN  
VS  
LOAD CAPACITANCE**

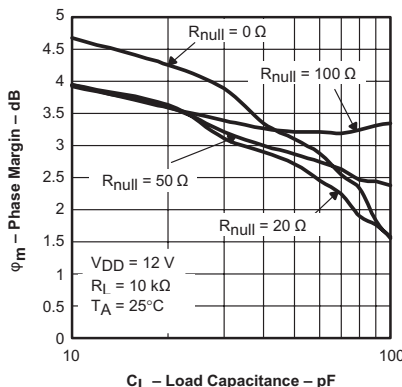


Figure 22.

**GAIN BANDWIDTH PRODUCT  
VS  
SUPPLY VOLTAGE**

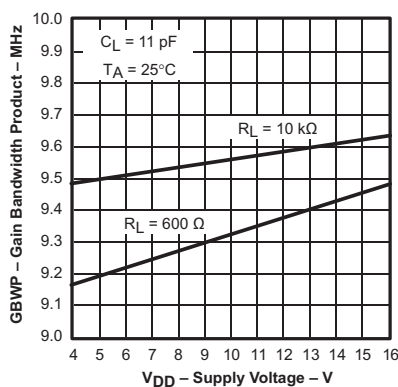


Figure 23.

**SLEW RATE  
VS  
SUPPLY VOLTAGE**

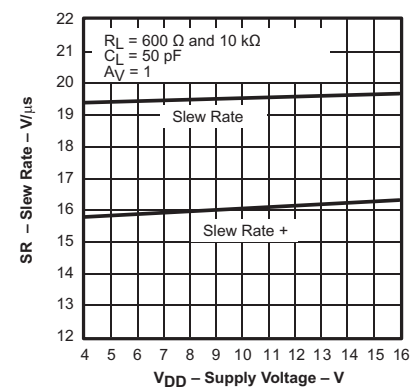


Figure 24.

## TYPICAL CHARACTERISTICS

**SLEW RATE  
VS  
FREE-AIR TEMPERATURE**

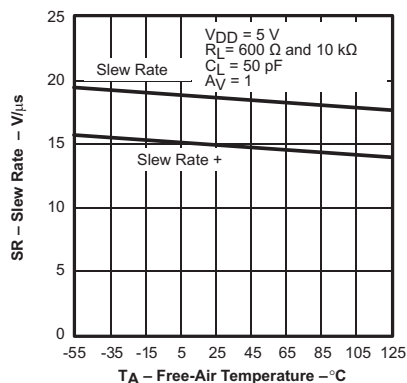


Figure 25.

**SLEW RATE  
VS  
FREE-AIR TEMPERATURE**

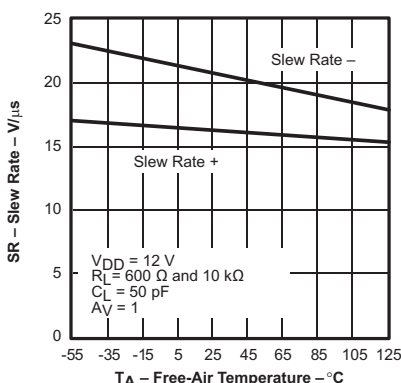


Figure 26.

**TOTAL HARMONIC DISTORTION  
PLUS NOISE  
VS  
FREQUENCY**

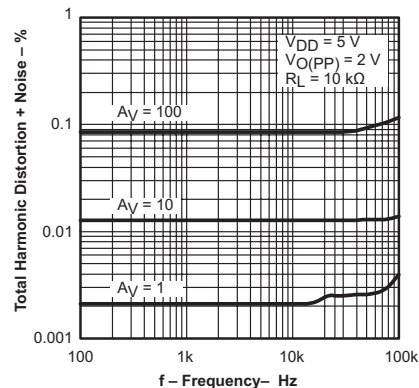


Figure 27.

**TOTAL HARMONIC DISTORTION  
PLUS NOISE  
VS  
FREQUENCY**

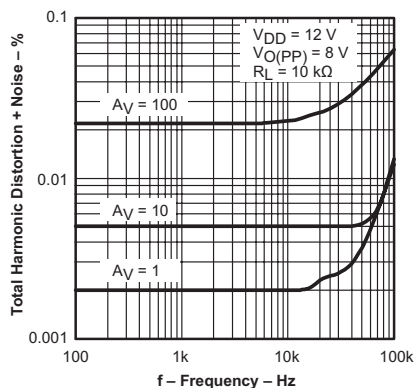


Figure 28.

**TOTAL HARMONIC DISTORTION  
PLUS NOISE  
VS  
PEAK-TO-PEAK OUTPUT VOLTAGE**

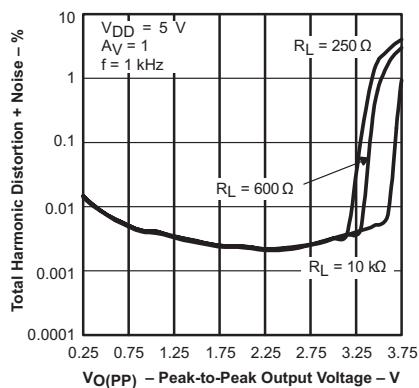


Figure 29.

**TOTAL HARMONIC DISTORTION  
PLUS NOISE  
VS  
PEAK-TO-PEAK OUTPUT VOLTAGE**

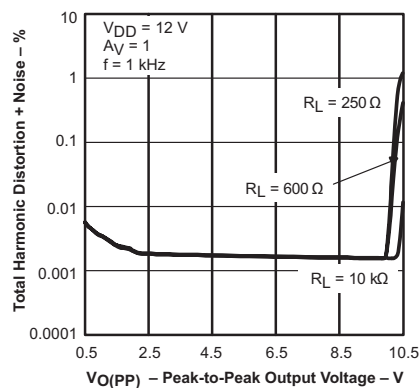


Figure 30.

**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**

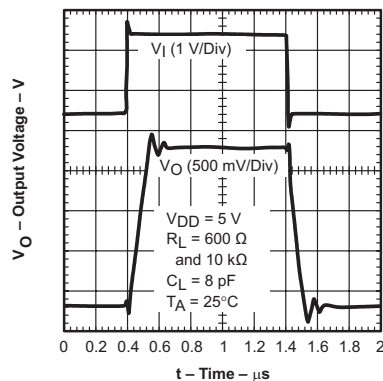


Figure 31.

**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**

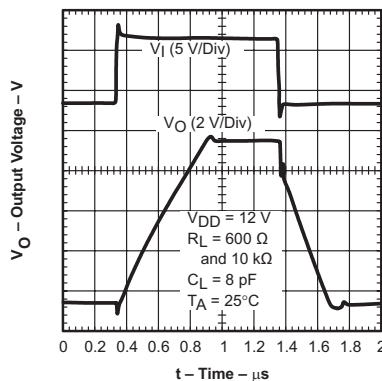


Figure 32.

**SMALL SIGNAL FOLLOWER  
PULSE RESPONSE**

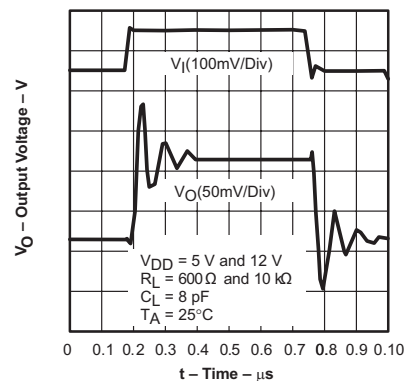


Figure 33.

## TYPICAL CHARACTERISTICS

**LARGE SIGNAL INVERTING  
PULSE RESPONSE**

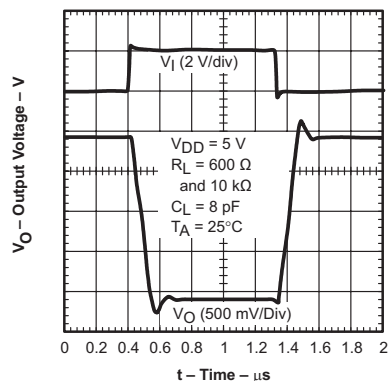


Figure 34.

**LARGE SIGNAL INVERTING  
PULSE RESPONSE**

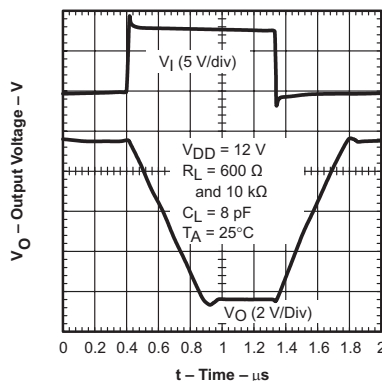


Figure 35.

**SMALL SIGNAL INVERTING  
PULSE RESPONSE**

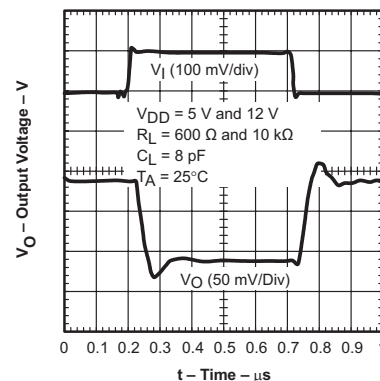


Figure 36.

**SHUTDOWN FORWARD  
ISOLATION  
VS  
FREQUENCY**

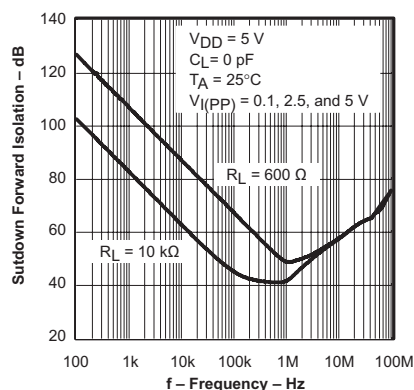


Figure 37.

**SHUTDOWN FORWARD  
ISOLATION  
VS  
FREQUENCY**

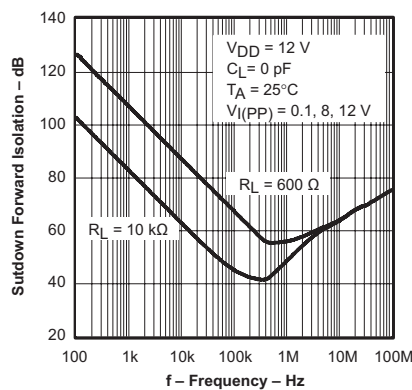


Figure 38.

**SHUTDOWN REVERSE  
ISOLATION  
VS  
FREQUENCY**

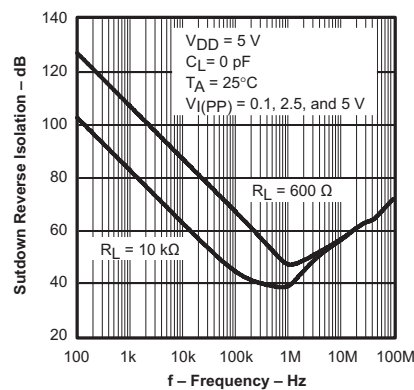


Figure 39.

**SHUTDOWN REVERSE  
ISOLATION  
VS  
FREQUENCY**

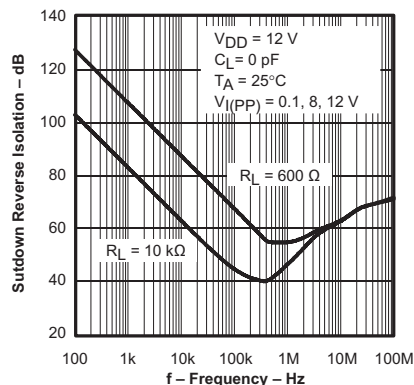


Figure 40.

**SHUTDOWN SUPPLY CURRENT  
VS  
SUPPLY VOLTAGE**

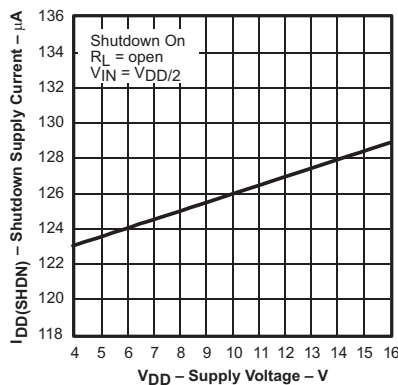


Figure 41.

**SHUTDOWN SUPPLY CURRENT  
VS  
FREE-AIR TEMPERATURE**

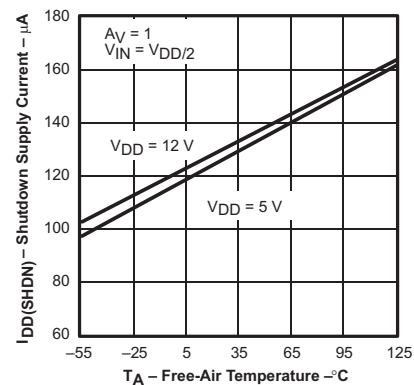


Figure 42.

## TYPICAL CHARACTERISTICS

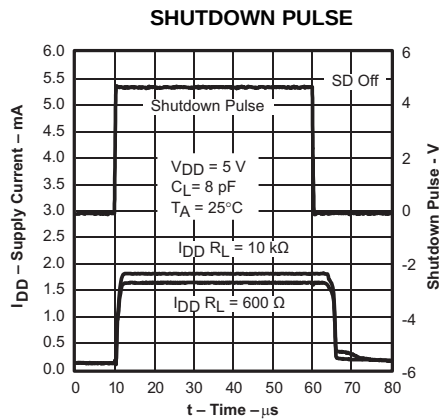


Figure 43.

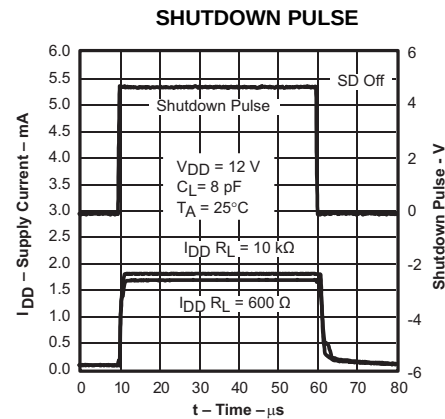


Figure 44.

## PARAMETER MEASUREMENT INFORMATION

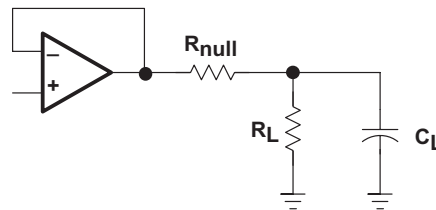


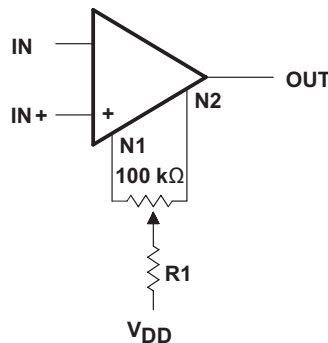
Figure 45

Figure 45.

## APPLICATION INFORMATION

### Input Offset Voltage Null Circuit

The TLC080 and TLC081 has an input offset nulling function. Refer to [Figure 46](#) for the diagram.



- A.  $R_1 = 5.6 \text{ k}\Omega$  for offset voltage adjustment of  $\pm 10 \text{ mV}$ .  $R_1 = 20 \text{ k}\Omega$  for offset voltage adjustment of  $\pm 3 \text{ mV}$ .

Figure 46. Input Offset Voltage Null Circuit

## Driving a Capacitive Load

When the amplifier is configured in this manner, capacitive loading directly on the output will decrease the device's phase margin leading to high frequency ringing or oscillations. Therefore, for capacitive loads of greater than 10 pF, it is recommended that a resistor be placed in series ( $R_{NULL}$ ) with the output of the amplifier, as shown in [Figure 47](#). A minimum value of 20  $\Omega$  should work well for most applications.

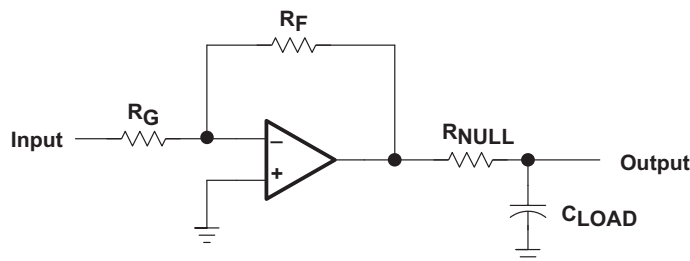


Figure 47. Driving a Capacitive Load

## Offset Voltage

The output offset voltage, ( $V_{OO}$ ) is the sum of the input offset voltage ( $V_{IO}$ ) and both input bias currents ( $I_{IB}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage:

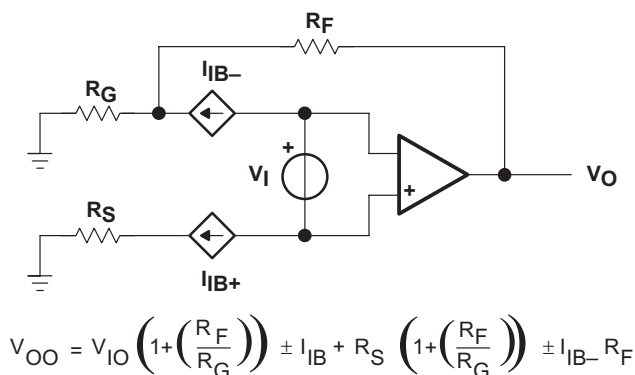


Figure 48. Output Offset Voltage Model

## High Speed CMOS Input Amplifiers

The TLC08x is a family of high-speed low-noise CMOS input operational amplifiers that has an input capacitance of the order of 20 pF. Any resistor used in the feedback path adds a pole in the transfer function equivalent to the input capacitance multiplied by the combination of source resistance and feedback resistance. For example, a gain of  $-10$ , a source resistance of 1 k $\Omega$ , and a feedback resistance of 10 k $\Omega$  add an additional pole at approximately 8 MHz. This is more apparent with CMOS amplifiers than bipolar amplifiers due to their greater input capacitance.

This is of little consequence on slower CMOS amplifiers, as this pole normally occurs at frequencies above their unity-gain bandwidth. However, the TLC08x with its 10-MHz bandwidth means that this pole normally occurs at frequencies where there is on the order of 5dB gain left and the phase shift adds considerably.

The effect of this pole is the strongest with large feedback resistances at small closed loop gains. As the feedback resistance is increased, the gain peaking increases at a lower frequency and the 180° phase shift crossover point also moves down in frequency, decreasing the phase margin.

For the TLC08x, the maximum feedback resistor recommended is 5 k $\Omega$ ; larger resistances can be used but a capacitor in parallel with the feedback resistor is recommended to counter the effects of the input capacitance pole.

The TLC083 with a 1-V step response has an 80% overshoot with a natural frequency of 3.5 MHz when configured as a unity gain buffer and with a 10-k $\Omega$  feedback resistor. By adding a 10-pF capacitor in parallel with the feedback resistor, the overshoot is reduced to 40% and eliminates the natural frequency, resulting in a much faster settling time (see Figure 49). The 10-pF capacitor was chosen for convenience only.

Load capacitance had little effect on these measurements due to the excellent output drive capability of the TLC08x.

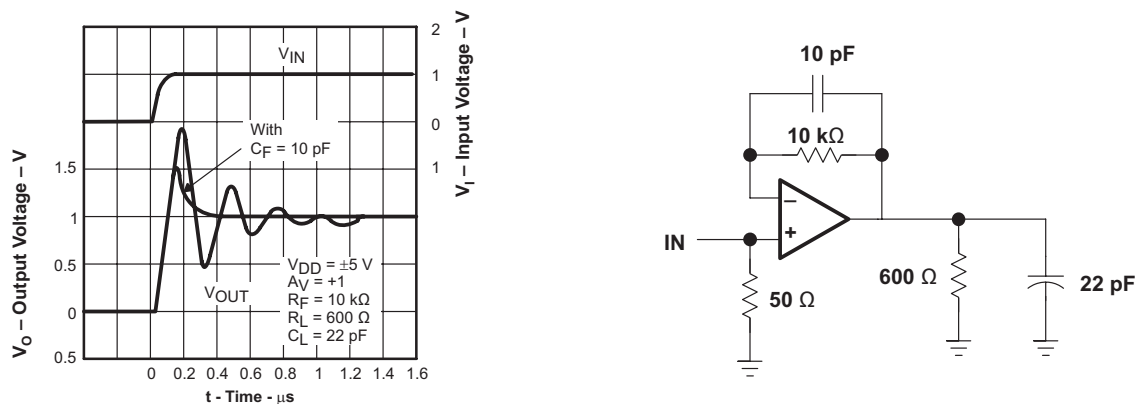
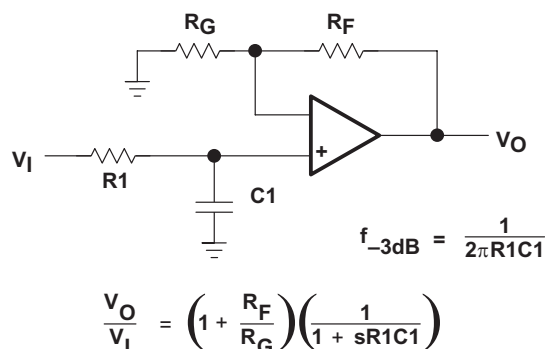


Figure 49. 1-V Step Response

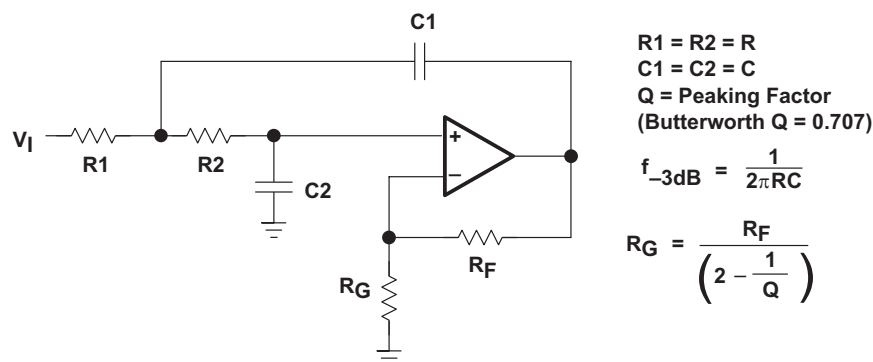
## General Configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the [Figure 50](#) system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see ).



**Figure 50. Single-Pole Low-Pass Filter**

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.



**Figure 51. 2-Pole Low-Pass Sallen-Key Filter**

## Shutdown Function

Three members of the TLC08x family (TLC080/3/5) have a shutdown terminal (SHDN) for conserving battery life in portable applications. When the shutdown terminal is tied low, the supply current is reduced to 125  $\mu$ A/channel, the amplifier is disabled, and the outputs are placed in a high-impedance mode. To enable the amplifier, the shutdown terminal can either be left floating or pulled high. When the shutdown terminal is left floating, care should be taken to ensure that parasitic leakage current at the shutdown terminal does not inadvertently place the operational amplifier into shutdown. The shutdown terminal threshold is always referenced to the voltage on the GND terminal of the device. Therefore, when operating the device with split supply voltages (e.g.  $\pm 2.5$  V), the shutdown terminal needs to be pulled to  $V_{DD-}$  (not system ground) to disable the operational amplifier.

The amplifier's output with a shutdown pulse is shown in [Figure 43](#) and [Figure 44](#). The amplifier is powered with a single 5-V supply and is configured as noninverting with a gain of 5. The amplifier turnon and turnoff times are measured from the 50% point of the shutdown pulse to the 50% point of the output waveform. The times for the single, dual, and quad are listed in the data tables.

[Figure 37](#) through [Figure 40](#) show the amplifiers forward and reverse isolation in shutdown. The operational amplifier is configured as a voltage follower ( $A_v = 1$ ). The isolation performance is plotted across frequency using 0.1  $V_{PP}$ , 2.5  $V_{PP}$ , and 5  $V_{PP}$  input signals at  $\pm 2.5$  V supplies and 0.1  $V_{PP}$ , 8  $V_{PP}$ , and 12  $V_{PP}$  input signals at  $\pm 6$  V supplies.

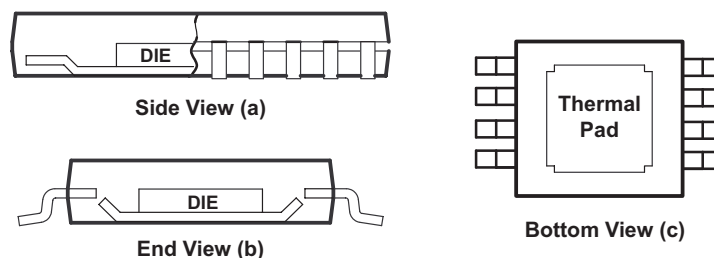
## Circuit Layout Considerations

To achieve the levels of high performance of the TLC08x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- **Ground planes** – It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- **Proper power supply decoupling** – Use a 6.8- $\mu$ F tantalum capacitor in parallel with a 0.1- $\mu$ F ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1- $\mu$ F ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1- $\mu$ F capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- **Sockets** – Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- **Short trace runs/compact part placements** – Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- **Surface-mount passive components** – Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.

## General PowerPAD Design Considerations

The TLC08x is available in a thermally-enhanced PowerPAD family of packages. These packages are constructed using a downset leadframe upon which the die is mounted [see [Figure 52\(a\)](#) and [Figure 52\(b\)](#)]. This arrangement results in the lead frame being exposed as a thermal pad on the underside of the package [see [Figure 52\(c\)](#)]. Because this thermal pad has direct thermal contact with the die, excellent thermal performance can be achieved by providing a good thermal path away from the thermal pad.



- A. The thermal pad is electrically isolated from all terminals in the package.

**Figure 52. Views of Thermally-Enhanced DGN Package**

The PowerPAD package allows for both assembly and thermal management in one manufacturing operation. During the surface-mount solder operation (when the leads are being soldered), the thermal pad must be soldered to a copper area underneath the package. Through the use of thermal paths within this copper area, heat can be conducted away from the package into either a ground plane or other heat dissipating device. **Soldering the PowerPAD to the printed circuit board (PCB) is always required, even with applications that have low power dissipation.** This soldering provides the necessary thermal and mechanical connection between the lead frame die pad and the PCB.

Although there are many ways to properly heatsink the PowerPAD package, the following steps illustrate the recommended approach.

The PowerPAD must be connected to the most negative supply voltage (GND pin potential) of the device.

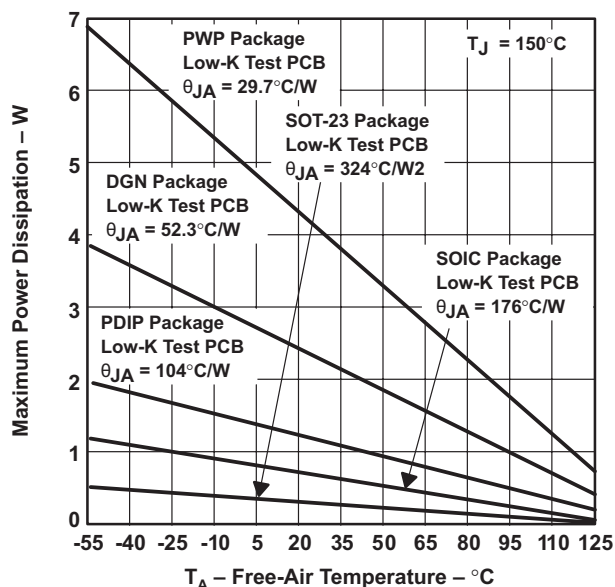
1. Prepare the PCB with a top side etch pattern (see the landing patterns at the end of this data sheet). There should be etch for the leads as well as etch for the thermal pad.
2. Place five holes (dual) or nine holes (quad) in the area of the thermal pad. These holes should be 13 mils in diameter. Keep them small so that solder wicking through the holes is not a problem during reflow.
3. Additional vias may be placed anywhere along the thermal plane outside of the thermal pad area. This helps dissipate the heat generated by the TLC08x IC. These additional vias may be larger than the 13-mil diameter vias directly under the thermal pad. They can be larger because they are not in the thermal pad area to be soldered so that wicking is not a problem.
4. Connect all holes to the internal plane that is at the same potential as the ground pin of the device.
5. When connecting these holes to this internal plane, do not use the typical web or spoke via connection methodology. Web connections have a high thermal resistance connection that is useful for slowing the heat transfer during soldering operations. This makes the soldering of vias that have plane connections easier. In this application, however, low thermal resistance is desired for the most efficient heat transfer. Therefore, the holes under the TLC08x PowerPAD package should make their connection to the internal ground plane with a complete connection around the entire circumference of the plated-through hole.
6. The top-side solder mask should leave the terminals of the package and the thermal pad area with its five holes (dual) or nine holes (quad) exposed. The bottom-side solder mask should cover the five or nine holes of the thermal pad area. This prevents solder from being pulled away from the thermal pad area during the reflow process.
7. Apply solder paste to the exposed thermal pad area and all of the IC terminals.
8. With these preparatory steps in place, the TLC08x IC is simply placed in position and run through the solder reflow operation as any standard surface-mount component. This results in a part that is properly installed.

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in [Figure 53](#) and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right) \quad (1)$$

Where:

|                 |                                                                     |
|-----------------|---------------------------------------------------------------------|
| $P_D$ =         | Maximum power dissipation of TLC08x IC (watts)                      |
| $T_{MAX}$ =     | Absolute maximum junction temperature (150°C)                       |
| $T_A$ =         | Free-ambient air temperature (°C)                                   |
| $\theta_{JA}$ = | $\theta_{JC} + \theta_{CA}$                                         |
|                 | $\theta_{JC}$ = Thermal coefficient from junction to case           |
|                 | $\theta_{CA}$ = Thermal coefficient from case to ambient air (°C/W) |



A. Results are with no air flow and using JEDEC Standard Low-K test PCB.

**Figure 53. Maximum Power Dissipation vs Free-Air Temperature**

The next consideration is the package constraints. The two sources of heat within an amplifier are quiescent power and output power. The designer should never forget about the quiescent heat generated within the device, especially multi-amplifier devices. Because these devices have linear output stages (Class A-B), most of the heat dissipation is at low output voltages with high output currents.

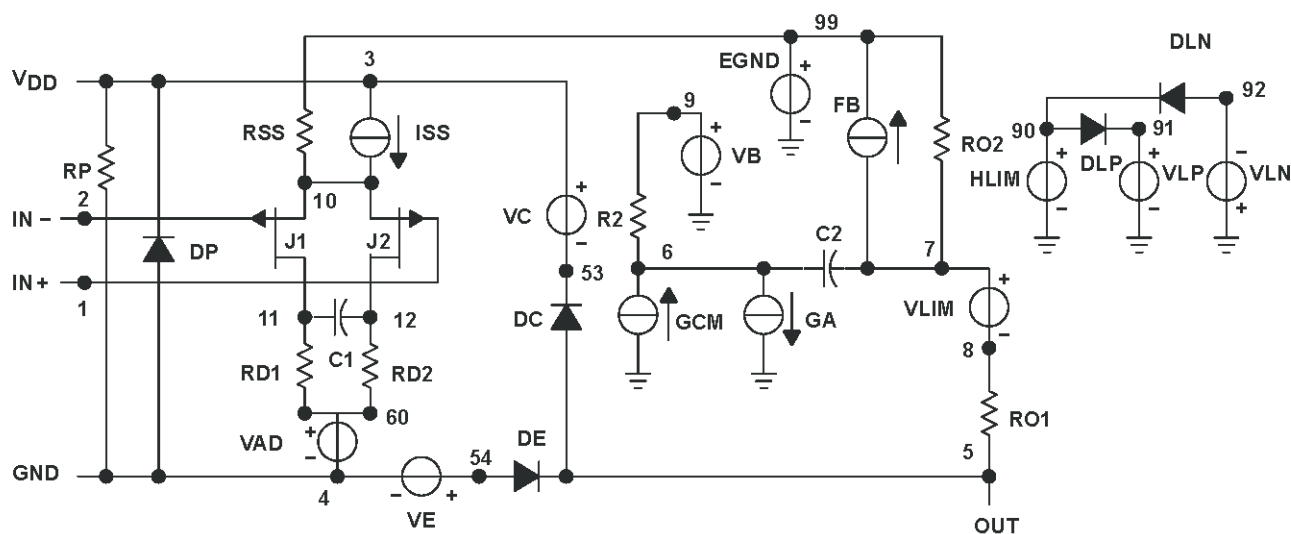
The other key factor when dealing with power dissipation is how the devices are mounted on the PCB. The PowerPAD devices are extremely useful for heat dissipation. But, the device should always be soldered to a copper plane to fully use the heat dissipation properties of the PowerPAD. The SOIC package, on the other hand, is highly dependent on how it is mounted on the PCB. As more trace and copper area is placed around the device,  $\theta_{JA}$  decreases and the heat dissipation capability increases. The currents and voltages shown in these graphs are for the total package. For the dual or quad amplifier packages, the sum of the RMS output currents and voltages should be used to choose the proper package.

## Macromodel Information

Macromodel information provided was derived using Microsim Parts™, the model generation software used with Microsim PSpice™. The Boyle macromodel (see <sup>(1)</sup>) and subcircuit in [Figure 54](#) are generated using the TLC08x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

- (1) G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," IEEE Journal of Solid-State Circuits, SC-9, 353 (1974).



\*DEVICE=TLC08X\_5V, OPAMP, PJF, INT

\* TLC08X\_5V – 5V operational amplifier "macromodel" sub-circuit

\* created using Parts release 8.0 on 12/16/99 at 14:03

\* Parts is a MicroSim product.

\* connections:

\* non-inverting input  
\* inverting input  
\* positive power supply  
\* negative power supply  
\* output

.subckt TLC08X\_5V 1 2 3 4 5

\*  
c1 11 12 4.6015E-12  
c2 6 7 8.0000E-12  
css 10 99 986.29E-15  
dc 5 53 dy  
de 54 5 dy  
dlp 90 91 dx  
dln 92 90 dx  
dp 4 3 dx  
egnd 99 0 poly(2) (3,0) (4,0) 0 .5 .5  
fb 7 99 poly(5) vb vc ve vlp vln 0 13.984E6 -1E3 1E3  
14E6 -14E6

```
ga 6 0 11 12 402.12E-6
gcm 0 6 10 99 1.5735E-6
ioff 0 6 dc 1.212E-6
iss 3 10 dc 130.40E-6
hlim 90 0 vlim 1K
j1 11 2 10 jx1
j2 12 1 10 jx2
r2 6 9 100.00E3
rd1 4 11 2.4868E3
rd2 4 12 2.4868E3
ro1 8 5 10
ro2 7 99 10
rp 3 4 2.8249E3
rss 10 99 1.5337E6
vb 9 0 dc 0
vc 3 53 dc 1.5537
ve 54 4 dc .84373
vlim 7 8 dc 0
vlp 91 0 dc 117.60
vln 0 92 dc 117.60
.model dx D(Is=800.00E-18)
.model dy D(Is=800.00E-18 Rs=1m Cjo=10p)
.model jx1 PJF(Is=80.000E-15 Beta=1.2401E-3 Vto=-1)
.model jx2 PJF(Is=80.000E-15 Beta=1.2401E-3 Vto=-1)
.ends
```

Figure 54. Boyle Macromodel and Subcircuit

## REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision E (April 2006) to Revision F                                       | Page               |
|------------------------------------------------------------------------------------------|--------------------|
| <ul style="list-style-type: none"> <li>Updated <a href="#">Figure 9</a> .....</li> </ul> | <a href="#">10</a> |

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TLC080AIDR</a>  | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080AI              |
| TLC080AIDR.A                | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080AI              |
| <a href="#">TLC080AIP</a>   | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC080AI            |
| TLC080AIP.A                 | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC080AI            |
| <a href="#">TLC080CDGNR</a> | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ACW                 |
| TLC080CDGNR.A               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ACW                 |
| TLC080CDGNRG4               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | -           | Call TI                              | Call TI                           | 0 to 70      |                     |
| <a href="#">TLC080CDR</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C080C               |
| TLC080CDR.A                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C080C               |
| <a href="#">TLC080ID</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080I               |
| TLC080ID.A                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080I               |
| <a href="#">TLC080IDGNR</a> | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | ACX                 |
| TLC080IDGNR.A               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | ACX                 |
| <a href="#">TLC080IDR</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080I               |
| TLC080IDR.A                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C080I               |
| <a href="#">TLC081AID</a>   | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081AI              |
| TLC081AID.A                 | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081AI              |
| <a href="#">TLC081AIDR</a>  | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081AI              |
| TLC081AIDR.A                | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081AI              |
| <a href="#">TLC081AIP</a>   | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC081AI            |
| TLC081AIP.A                 | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC081AI            |
| <a href="#">TLC081CD</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C081C               |
| TLC081CD.A                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C081C               |
| <a href="#">TLC081CDGNR</a> | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ACY                 |
| TLC081CDGNR.A               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ACY                 |
| <a href="#">TLC081CDR</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C081C               |
| TLC081CDR.A                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C081C               |
| <a href="#">TLC081CP</a>    | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC081C             |
| TLC081CP.A                  | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC081C             |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TLC081ID</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081I               |
| TLC081ID.A                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081I               |
| <a href="#">TLC081IDGNR</a> | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | ACZ                 |
| TLC081IDGNR.A               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | ACZ                 |
| <a href="#">TLC081IDR</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081I               |
| TLC081IDR.A                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C081I               |
| <a href="#">TLC081IP</a>    | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC081I             |
| TLC081IP.A                  | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC081I             |
| <a href="#">TLC082AID</a>   | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| TLC082AID.A                 | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| TLC082AID.B                 | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| <a href="#">TLC082AIDR</a>  | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| TLC082AIDR.A                | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| TLC082AIDR.B                | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082AI              |
| TLC082AIDRG4                | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   |                     |
| <a href="#">TLC082AIP</a>   | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C082AI              |
| TLC082AIP.A                 | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C082AI              |
| <a href="#">TLC082CD</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| TLC082CD.A                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| TLC082CD.B                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| TLC082CDG4                  | Active        | Production           | SOIC (D)   8     | 75   TUBE             | -           | Call TI                              | Call TI                           | 0 to 70      |                     |
| <a href="#">TLC082CDGN</a>  | Active        | Production           | HVSSOP (DGN)   8 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| TLC082CDGN.A                | Active        | Production           | HVSSOP (DGN)   8 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| TLC082CDGN.B                | Active        | Production           | HVSSOP (DGN)   8 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| <a href="#">TLC082CDGNR</a> | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| TLC082CDGNR.A               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| TLC082CDGNR.B               | Active        | Production           | HVSSOP (DGN)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ADZ                 |
| <a href="#">TLC082CDR</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| TLC082CDR.A                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| TLC082CDR.B                 | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C082C               |
| <a href="#">TLC082CP</a>    | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | C082C               |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLC082CP.A                  | Active        | Production           | PDIP (P)   8      | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | C082C               |
| TLC082CP.B                  | Active        | Production           | PDIP (P)   8      | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | C082C               |
| <a href="#">TLC082ID</a>    | Active        | Production           | SOIC (D)   8      | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| TLC082ID.A                  | Active        | Production           | SOIC (D)   8      | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| TLC082ID.B                  | Active        | Production           | SOIC (D)   8      | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| <a href="#">TLC082IDGN</a>  | Active        | Production           | HVSSOP (DGN)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| TLC082IDGN.A                | Active        | Production           | HVSSOP (DGN)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| TLC082IDGN.B                | Active        | Production           | HVSSOP (DGN)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| <a href="#">TLC082IDGNR</a> | Active        | Production           | HVSSOP (DGN)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| TLC082IDGNR.A               | Active        | Production           | HVSSOP (DGN)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| TLC082IDGNR.B               | Active        | Production           | HVSSOP (DGN)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEA                 |
| <a href="#">TLC082IDR</a>   | Active        | Production           | SOIC (D)   8      | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| TLC082IDR.A                 | Active        | Production           | SOIC (D)   8      | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| TLC082IDR.B                 | Active        | Production           | SOIC (D)   8      | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C082I               |
| TLC082IDRG4                 | Active        | Production           | SOIC (D)   8      | 2500   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   |                     |
| <a href="#">TLC082IP</a>    | Active        | Production           | PDIP (P)   8      | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C082I               |
| TLC082IP.A                  | Active        | Production           | PDIP (P)   8      | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C082I               |
| <a href="#">TLC083AID</a>   | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C083AI              |
| TLC083AID.A                 | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C083AI              |
| <a href="#">TLC083CDGQR</a> | Active        | Production           | HVSSOP (DGQ)   10 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AEB                 |
| TLC083CDGQR.A               | Active        | Production           | HVSSOP (DGQ)   10 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AEB                 |
| TLC083CDGQR.B               | Active        | Production           | HVSSOP (DGQ)   10 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AEB                 |
| <a href="#">TLC083CDR</a>   | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C083C               |
| TLC083CDR.A                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C083C               |
| TLC083CDR.B                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | C083C               |
| <a href="#">TLC083CN</a>    | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | C083C               |
| TLC083CN.A                  | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | C083C               |
| <a href="#">TLC083IDGQ</a>  | Active        | Production           | HVSSOP (DGQ)   10 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEC                 |
| TLC083IDGQ.A                | Active        | Production           | HVSSOP (DGQ)   10 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEC                 |
| TLC083IDGQ.B                | Active        | Production           | HVSSOP (DGQ)   10 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AEC                 |
| <a href="#">TLC083IN</a>    | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C083I               |

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLC083IN.A                   | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | C083I               |
| <a href="#">TLC084AID</a>    | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AID.B                  | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDG4                  | Active        | Production           | SOIC (D)   14     | 50   TUBE             | -           | Call TI                              | Call TI                           | -40 to 125   |                     |
| <a href="#">TLC084AIDR</a>   | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDR.A                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDR.B                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDRG4                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDRG4.A               | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| TLC084AIDRG4.B               | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084AI            |
| <a href="#">TLC084AIN</a>    | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC084AI            |
| TLC084AIN.B                  | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC084AI            |
| <a href="#">TLC084AIPWP</a>  | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084AI            |
| TLC084AIPWP.B                | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084AI            |
| <a href="#">TLC084AIPWPR</a> | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084AI            |
| TLC084AIPWPR.B               | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084AI            |
| <a href="#">TLC084CD</a>     | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLC084C             |
| TLC084CD.B                   | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLC084C             |
| <a href="#">TLC084CDR</a>    | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLC084C             |
| TLC084CDR.A                  | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLC084C             |
| TLC084CDR.B                  | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLC084C             |
| <a href="#">TLC084CN</a>     | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC084C             |
| TLC084CN.A                   | Active        | Production           | PDIP (N)   14     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC084C             |
| <a href="#">TLC084CPWP</a>   | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC084C             |
| TLC084CPWP.A                 | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC084C             |
| <a href="#">TLC084CPWPR</a>  | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC084C             |
| TLC084CPWPR.B                | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC084C             |
| <a href="#">TLC084ID</a>     | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084I             |
| TLC084ID.B                   | Active        | Production           | SOIC (D)   14     | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084I             |
| <a href="#">TLC084IDR</a>    | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084I             |
| TLC084IDR.B                  | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC084I             |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLC084IDRG4                 | Active        | Production           | SOIC (D)   14     | 2500   LARGE T&R      | -           | Call TI                              | Call TI                           | -40 to 125   |                     |
| <a href="#">TLC084IPWP</a>  | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084I             |
| TLC084IPWP.B                | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084I             |
| <a href="#">TLC084IPWPR</a> | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084I             |
| TLC084IPWPR.B               | Active        | Production           | HTSSOP (PWP)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC084I             |
| <a href="#">TLC085AIDR</a>  | Active        | Production           | SOIC (D)   16     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC085AI            |
| TLC085AIDR.B                | Active        | Production           | SOIC (D)   16     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLC085AI            |
| <a href="#">TLC085AIN</a>   | Active        | Production           | PDIP (N)   16     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC085AI            |
| TLC085AIN.B                 | Active        | Production           | PDIP (N)   16     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLC085AI            |
| <a href="#">TLC085AIPWP</a> | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC085AI            |
| TLC085AIPWP.B               | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TLC085AI            |
| <a href="#">TLC085CN</a>    | Active        | Production           | PDIP (N)   16     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC085C             |
| TLC085CN.A                  | Active        | Production           | PDIP (N)   16     | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLC085C             |
| <a href="#">TLC085CPWP</a>  | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC085C             |
| TLC085CPWP.A                | Active        | Production           | HTSSOP (PWP)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | TLC085C             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF TLC082, TLC084 :**

- Automotive : [TLC082-Q1](#), [TLC084-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLC080AIDR  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC080CDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC080CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC080IDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC080IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC081AIDR  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC081CDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC081CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC081IDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC081IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC082AIDR  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC082CDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC082CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC082IDGNR | HVSSOP       | DGN             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLC082IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLC083CDGQR | HVSSOP       | DGQ             | 10   | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLC083CDR    | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLC084AIDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLC084AIDRG4 | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLC084AIPWPR | HTSSOP       | PWP             | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| TLC084CDR    | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLC084CPWPR  | HTSSOP       | PWP             | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| TLC084IDR    | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLC084IPWPR  | HTSSOP       | PWP             | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| TLC085AIDR   | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLC080AIDR  | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TLC080CDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC080CDR   | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TLC080IDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC080IDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC081AIDR  | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC081CDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC081CDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC081IDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC081IDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC082AIDR  | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC082CDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC082CDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC082IDGNR | HVSSOP       | DGN             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLC082IDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLC083CDGQR | HVSSOP       | DGQ             | 10   | 2500 | 358.0       | 335.0      | 35.0        |
| TLC083CDR   | SOIC         | D               | 14   | 2500 | 350.0       | 350.0      | 43.0        |
| TLC084AIDR  | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |

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| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLC084AIDRG4 | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TLC084AIPWPR | HTSSOP       | PWP             | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| TLC084CDR    | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TLC084CPWPR  | HTSSOP       | PWP             | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| TLC084IDR    | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TLC084IPWPR  | HTSSOP       | PWP             | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| TLC085AIDR   | SOIC         | D               | 16   | 2500 | 350.0       | 350.0      | 43.0        |

## TUBE



\*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC080AIP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC080AIP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC080ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC080ID    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC080ID.A  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC080ID.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081AID   | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC081AID   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081AID.A | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081AID.A | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC081AIP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC081AIP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC081CD    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081CD.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081CP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC081CP.A  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC081ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081ID.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC081IP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC081IP.A  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082AID   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082AID   | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082AID.A | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082AID.A | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082AID.B | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082AID.B | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082AIP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082AIP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082CD    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC082CD      | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082CD.A    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082CD.A    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082CD.B    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082CD.B    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082CP      | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082CP.A    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082CP.B    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082ID      | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082ID      | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082ID.A    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082ID.A    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082ID.B    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLC082ID.B    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLC082IP      | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC082IP.A    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLC083AID     | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC083AID.A   | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC083CN      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC083CN.A    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC083IN      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC083IN.A    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC084AID     | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084AID     | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084AID.B   | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084AID.B   | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084AIN     | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC084AIN.B   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC084AIPWP   | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC084AIPWP.B | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC084CD      | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084CD      | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084CD.B    | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084CD.B    | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084CN      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC084CN.A    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC084CPWP    | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC084CPWP.A  | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC084ID      | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084ID      | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084ID.B    | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| TLC084ID.B    | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLC084IPWP    | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |

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| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC084IPWP.B  | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC085AIN     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC085AIN.B   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC085AIPWP   | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC085AIPWP.B | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC085CN      | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC085CN.A    | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLC085CPWP    | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| TLC085CPWP.A  | PWP          | HTSSOP       | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |

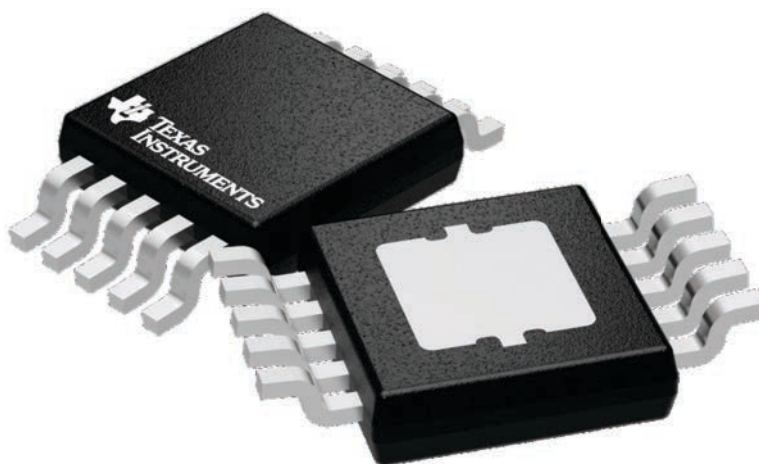
## GENERIC PACKAGE VIEW

**DGQ 10**

**PowerPAD™ HVSSOP - 1.1 mm max height**

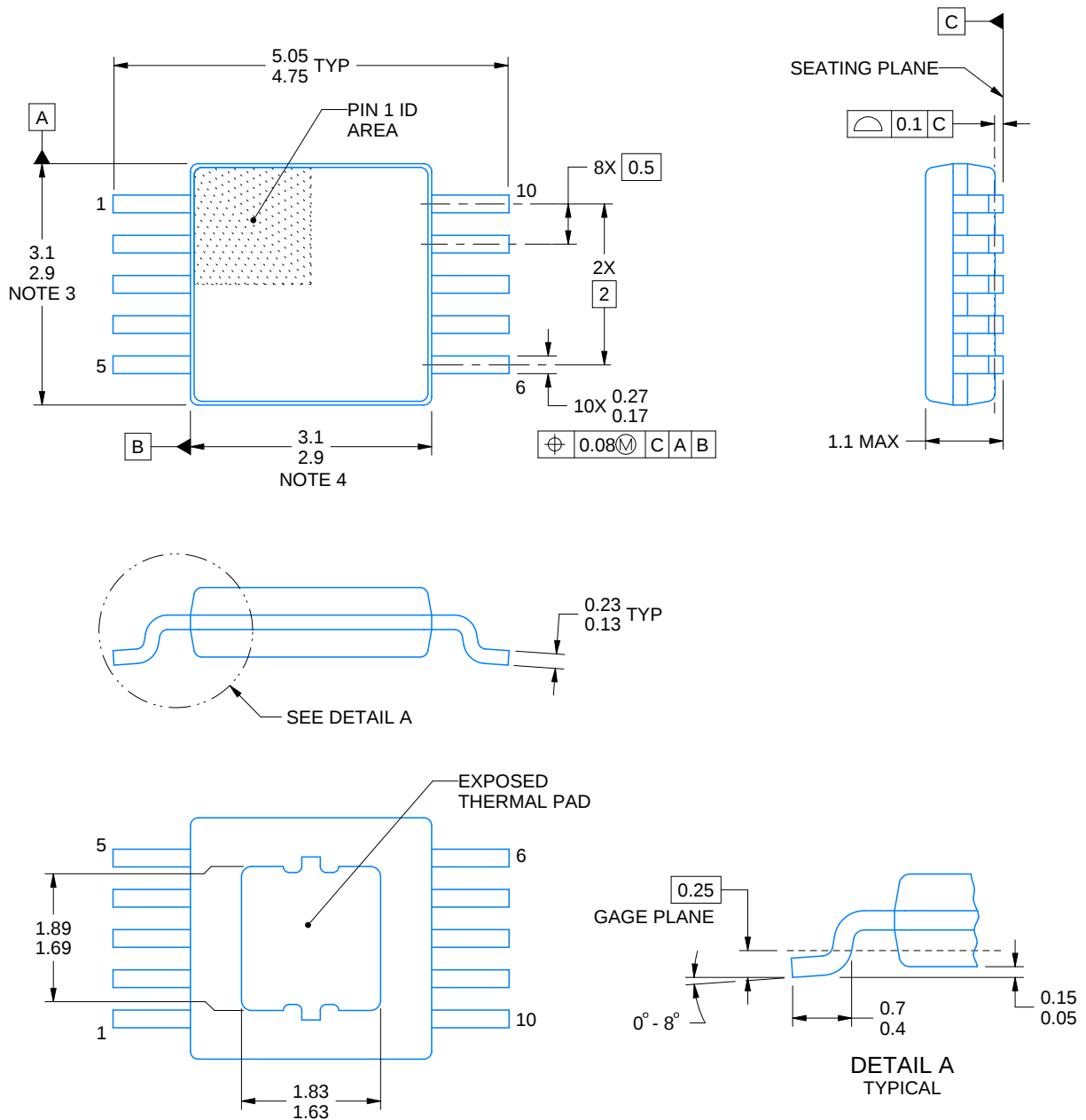
3 x 3, 0.5 mm pitch

PLASTIC SMALL OUTLINE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224775/A



4218842/B 04/2024

PowerPAD is a trademark of Texas Instruments.

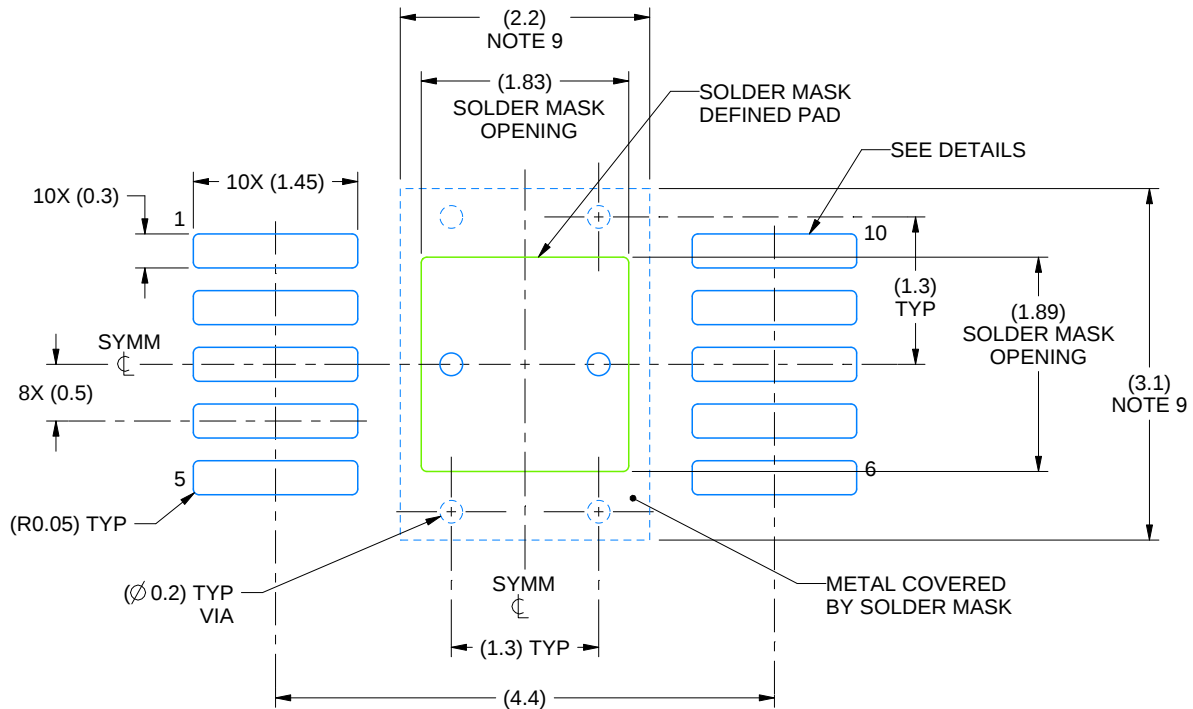
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187, variation BA-T.

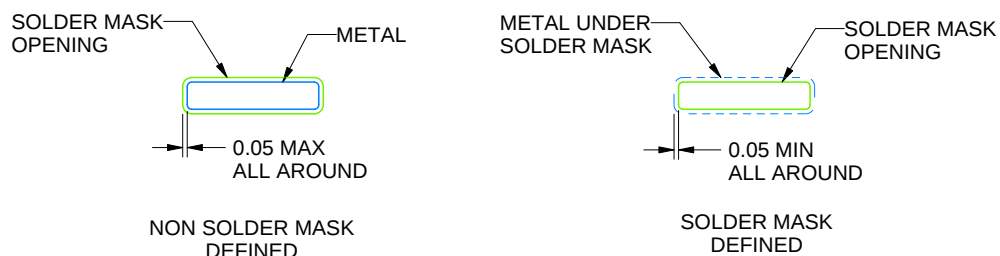
**DGQ0010D**

## PowerPAD™ - 1.1 mm max height

## PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:15X



## SOLDER MASK DETAILS

4218842/B 04/2024

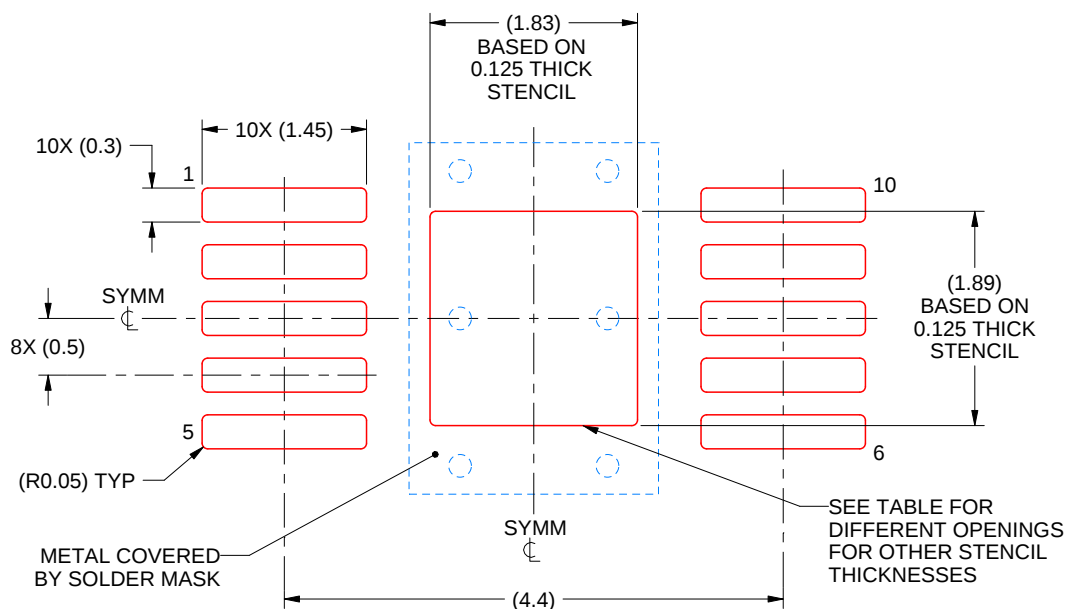
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002 ([www.ti.com/lit/slma002](http://www.ti.com/lit/slma002)) and SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).
9. Size of metal pad may vary due to creepage requirement.

**DGQ0010D**

## PowerPAD™ - 1.1 mm max height

## PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE  
EXPOSED PAD  
100% PRINTED SOLDER COVERAGE BY AREA  
SCALE:15X

| STENCIL THICKNESS | SOLDER STENCIL OPENING |
|-------------------|------------------------|
| 0.1               | 2.05 X 2.11            |
| 0.125             | 1.83 X 1.89 (SHOWN)    |
| 0.150             | 1.67 X 1.73            |
| 0.175             | 1.55 X 1.60            |

4218842/B 04/2024

NOTES: (continued)

10. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
11. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

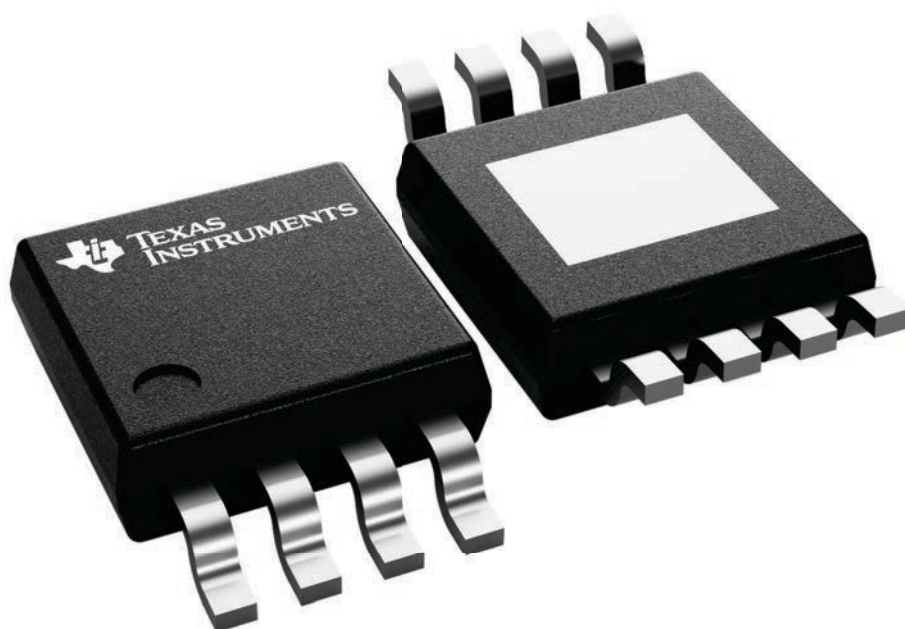
**DGN 8**

**PowerPAD™ HVSSOP - 1.1 mm max height**

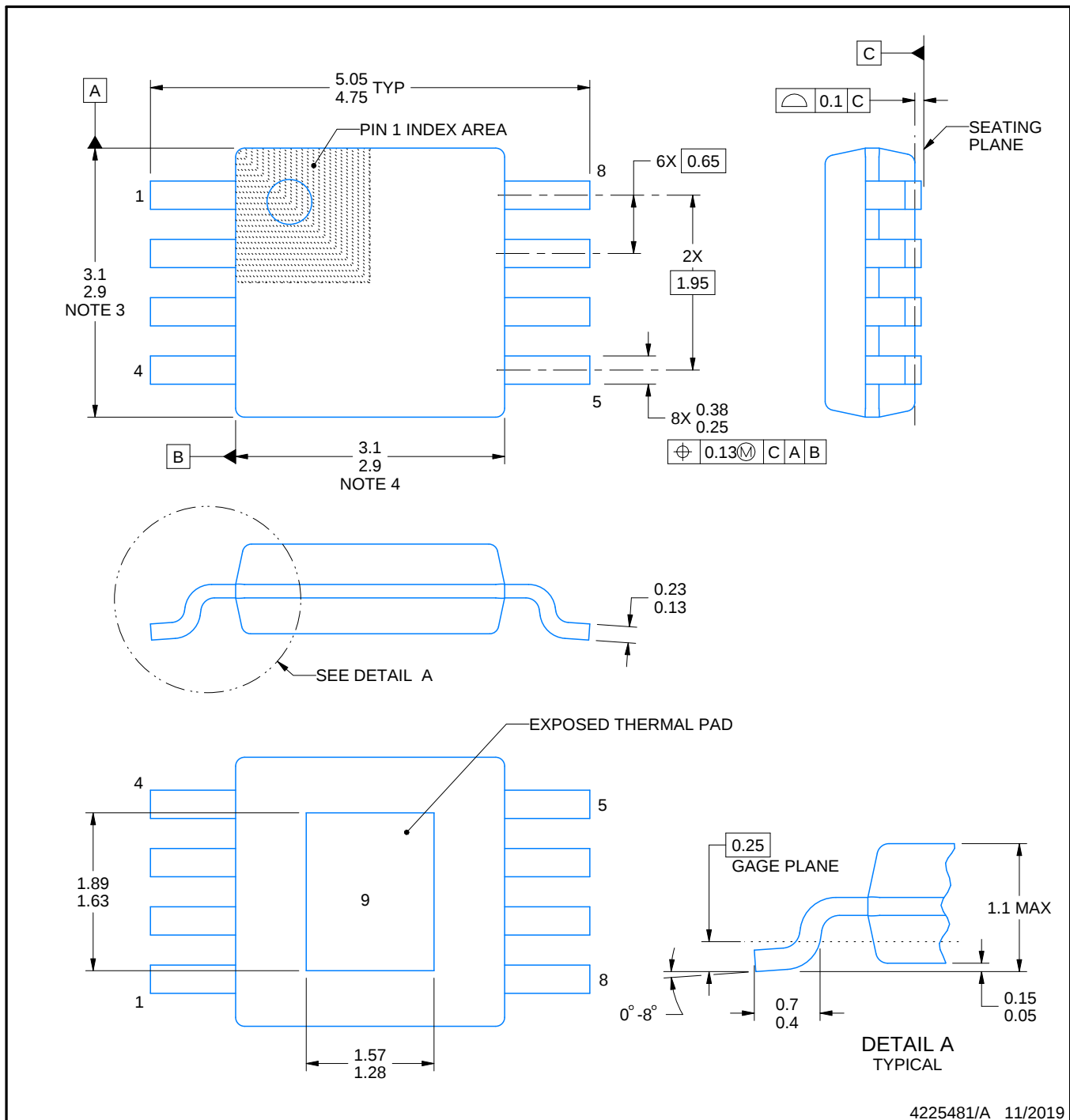
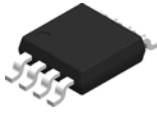
3 x 3, 0.65 mm pitch

SMALL OUTLINE PACKAGE

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4225482/B



4225481/A 11/2019

## NOTES:

PowerPAD is a trademark of Texas Instruments.

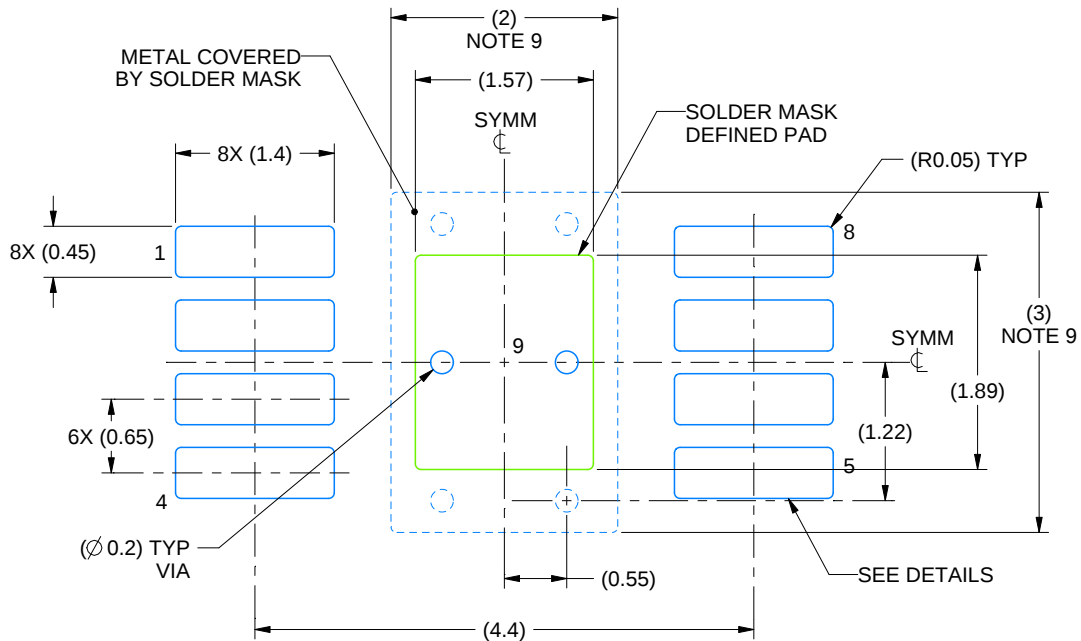
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187.

# EXAMPLE BOARD LAYOUT

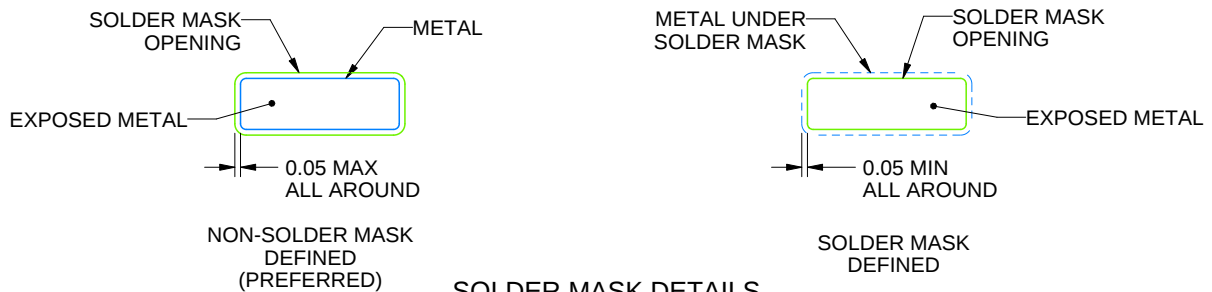
DGN0008D

PowerPAD™ VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 15X



SOLDER MASK DETAILS

4225481/A 11/2019

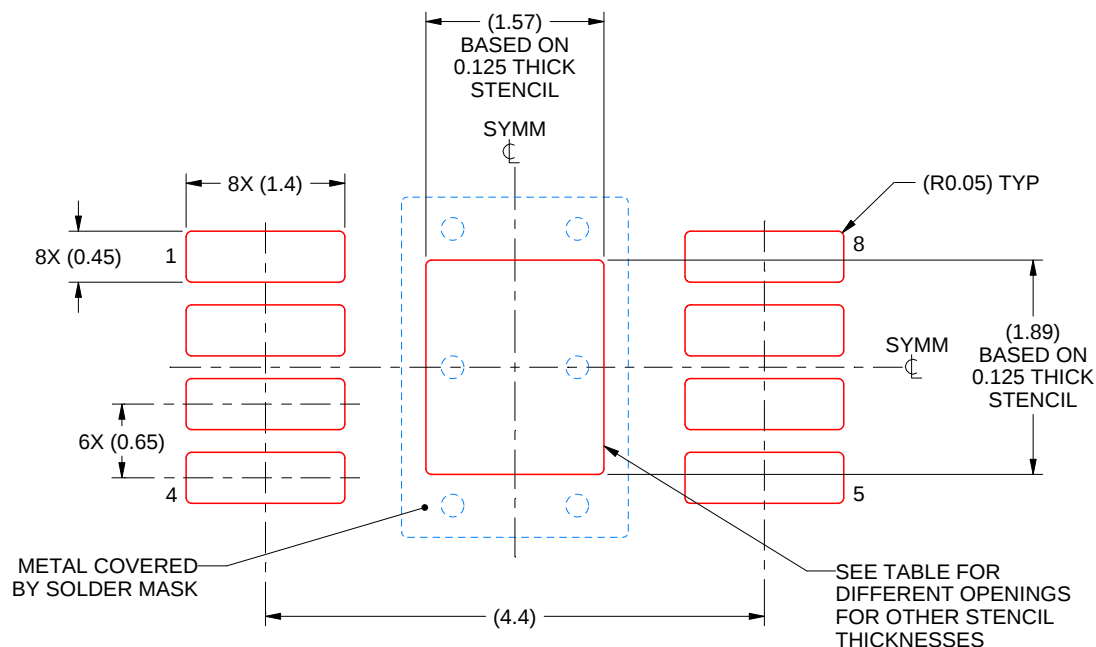
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.

**DGN0008D**

# PowerPAD™ VSSOP - 1.1 mm max height

## SMALL OUTLINE PACKAGE



## SOLDER PASTE EXAMPLE

EXPOSED PAD 9:  
100% PRINTED SOLDER COVERAGE BY AREA  
SCALE: 15X

| STENCIL THICKNESS | SOLDER STENCIL OPENING |
|-------------------|------------------------|
| 0.1               | 1.76 X 2.11            |
| 0.125             | 1.57 X 1.89 (SHOWN)    |
| 0.15              | 1.43 X 1.73            |
| 0.175             | 1.33 X 1.60            |

4225481/A 11/2019

NOTES: (continued)

10. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
11. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

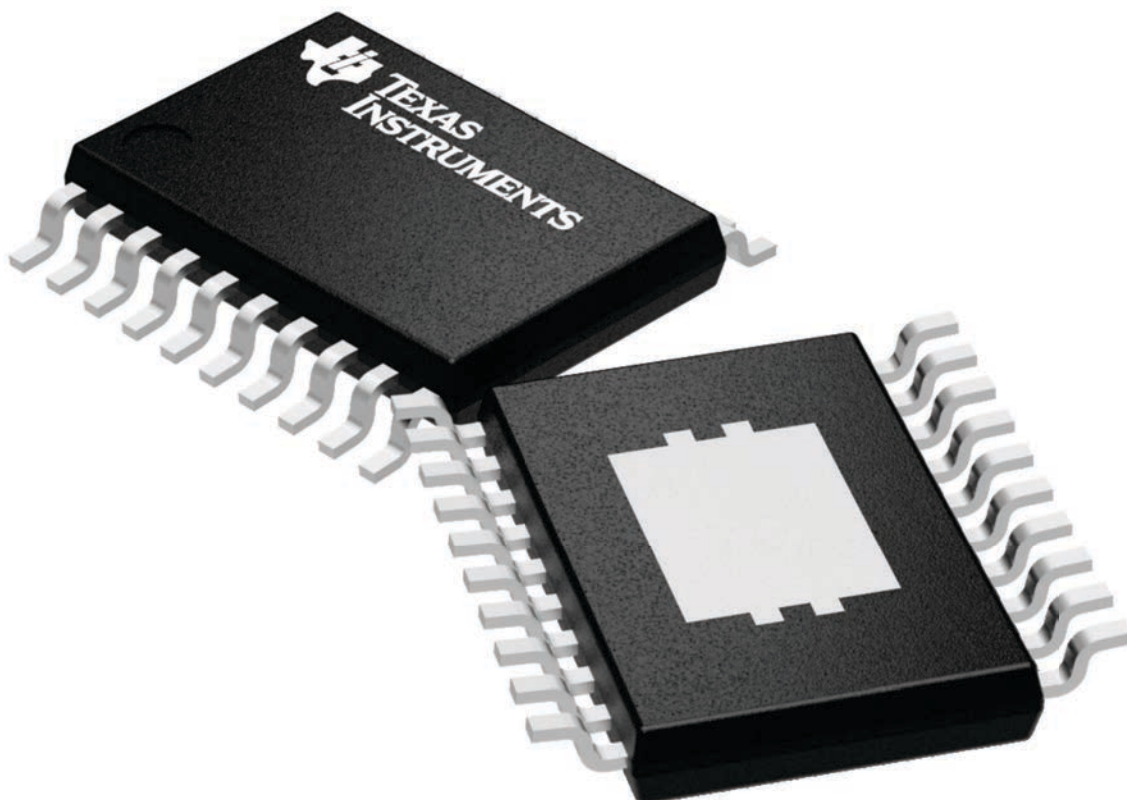
**PWP 20**

**HTSSOP - 1.2 mm max height**

6.5 x 4.4, 0.65 mm pitch

SMALL OUTLINE PACKAGE

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4224669/A



## PowerPAD™ TSSOP - 1.2 mm max height

[illegible]

PowerPAD is a trademark of Texas Instruments.

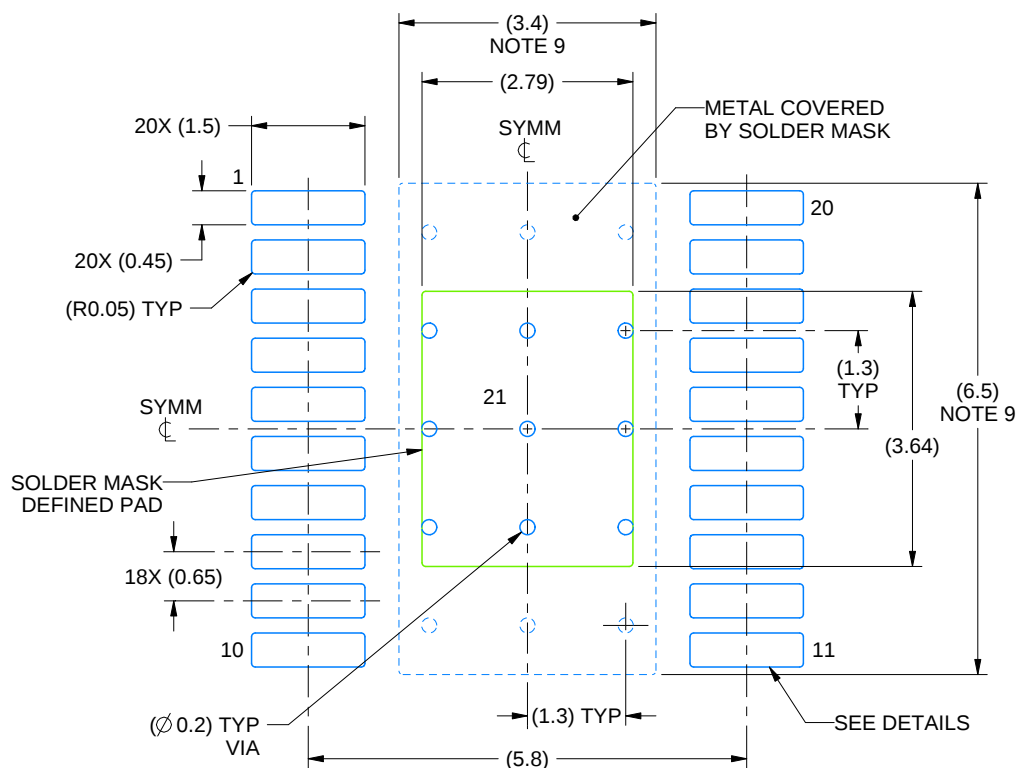
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.
5. Features may differ or may not be present.

# EXAMPLE BOARD LAYOUT

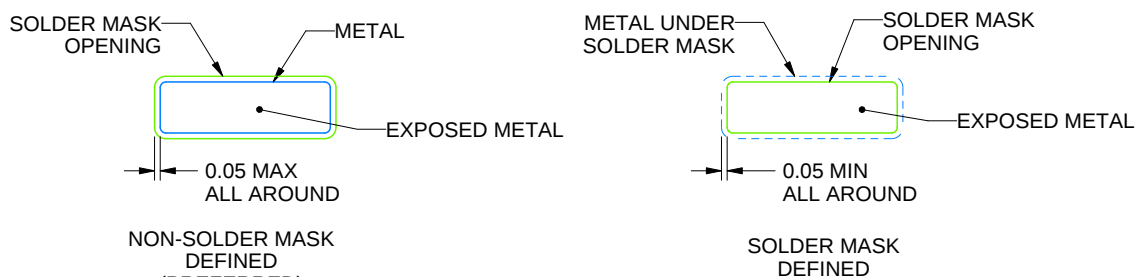
PWP0020W

PowerPAD™ TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4231145/A 08/2024

NOTES: (continued)

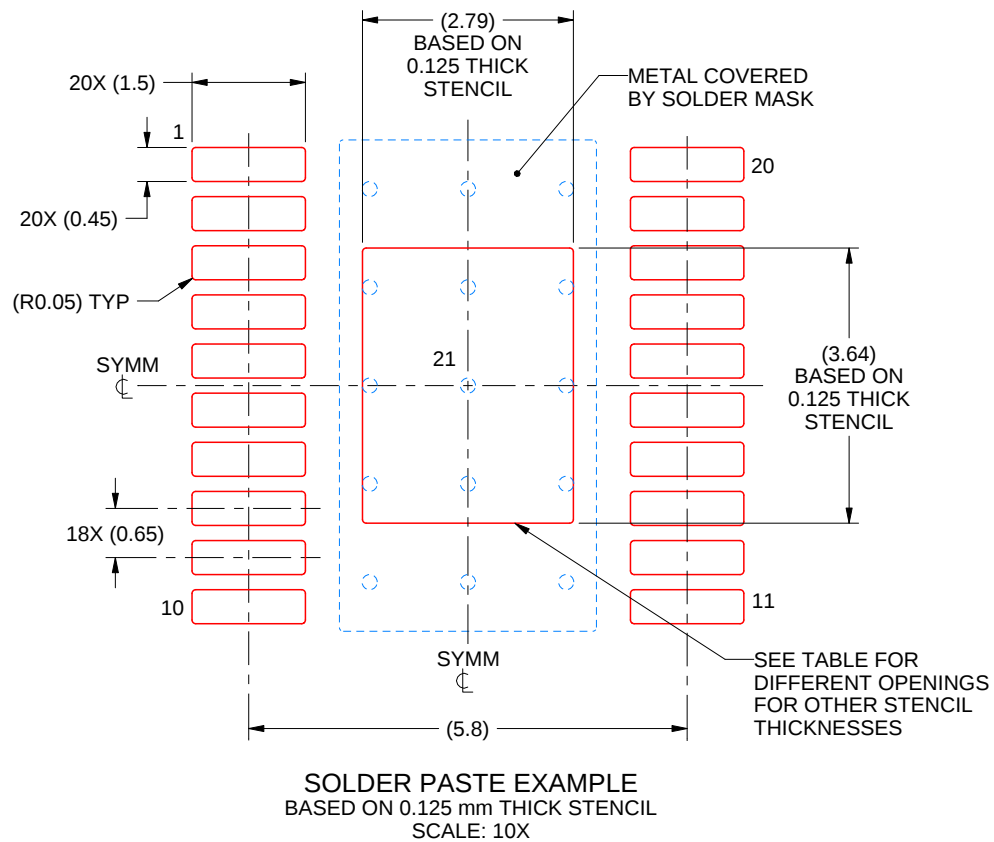
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002 ([www.ti.com/lit/slma002](http://www.ti.com/lit/slma002)) and SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).
9. Size of metal pad may vary due to creepage requirement.
10. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

PWP0020W

PowerPAD™ TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE

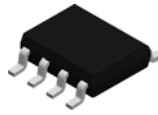


| STENCIL THICKNESS | SOLDER STENCIL OPENING |
|-------------------|------------------------|
| 0.1               | 3.12 X 4.07            |
| 0.125             | 2.79 X 3.64 (SHOWN)    |
| 0.15              | 2.55 X 3.32            |
| 0.175             | 2.36 X 3.08            |

4231145/A 08/2024

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

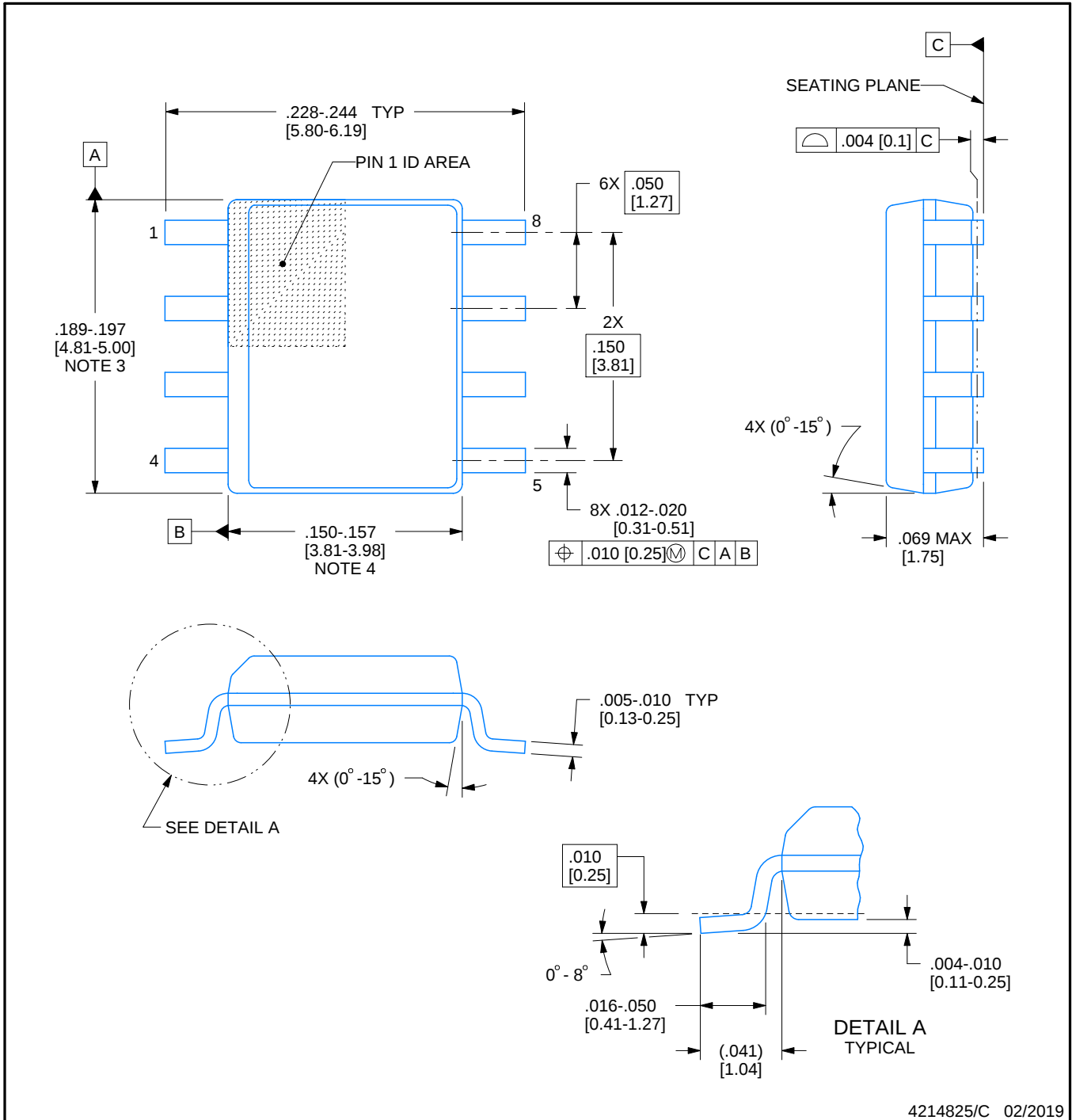


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

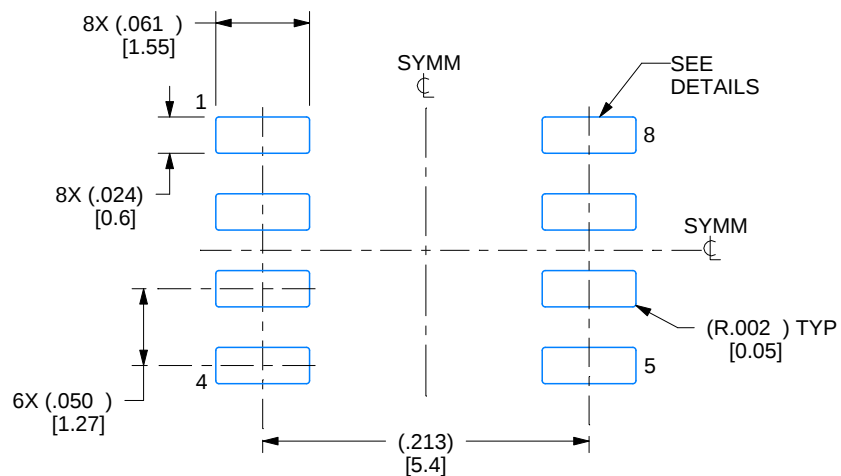
## NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

**D0008A**

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



## SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE

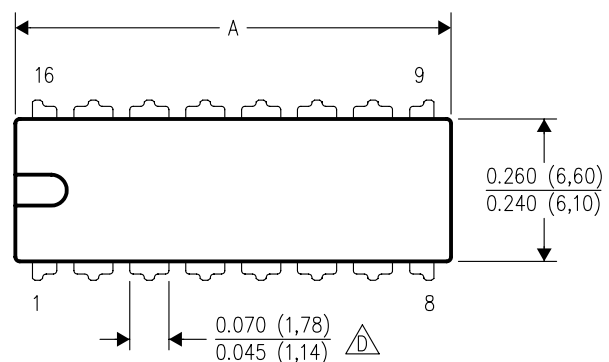


- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

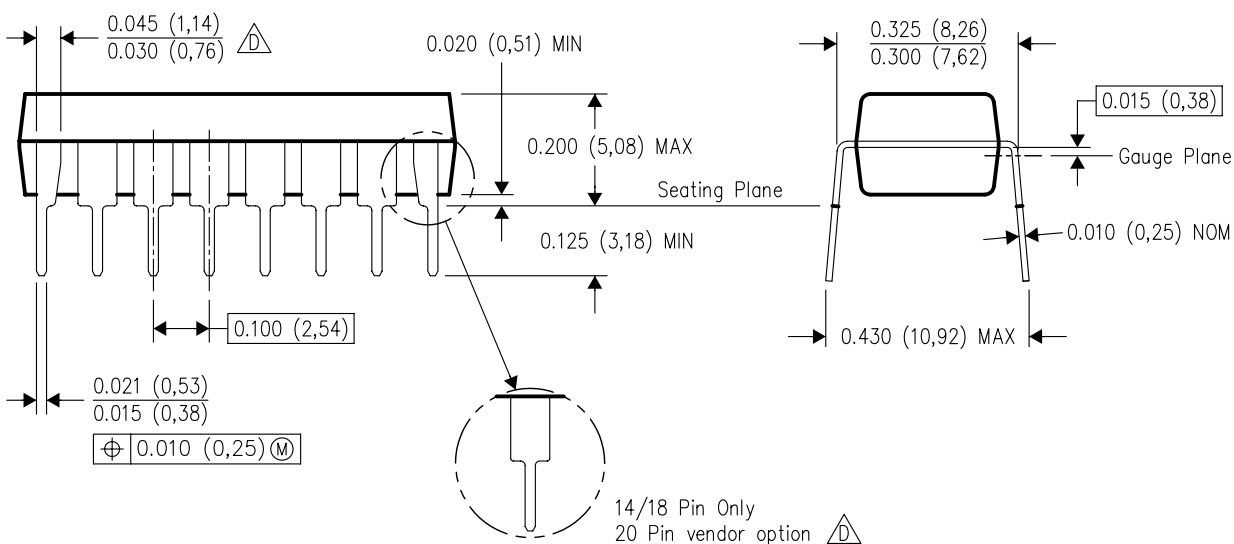
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



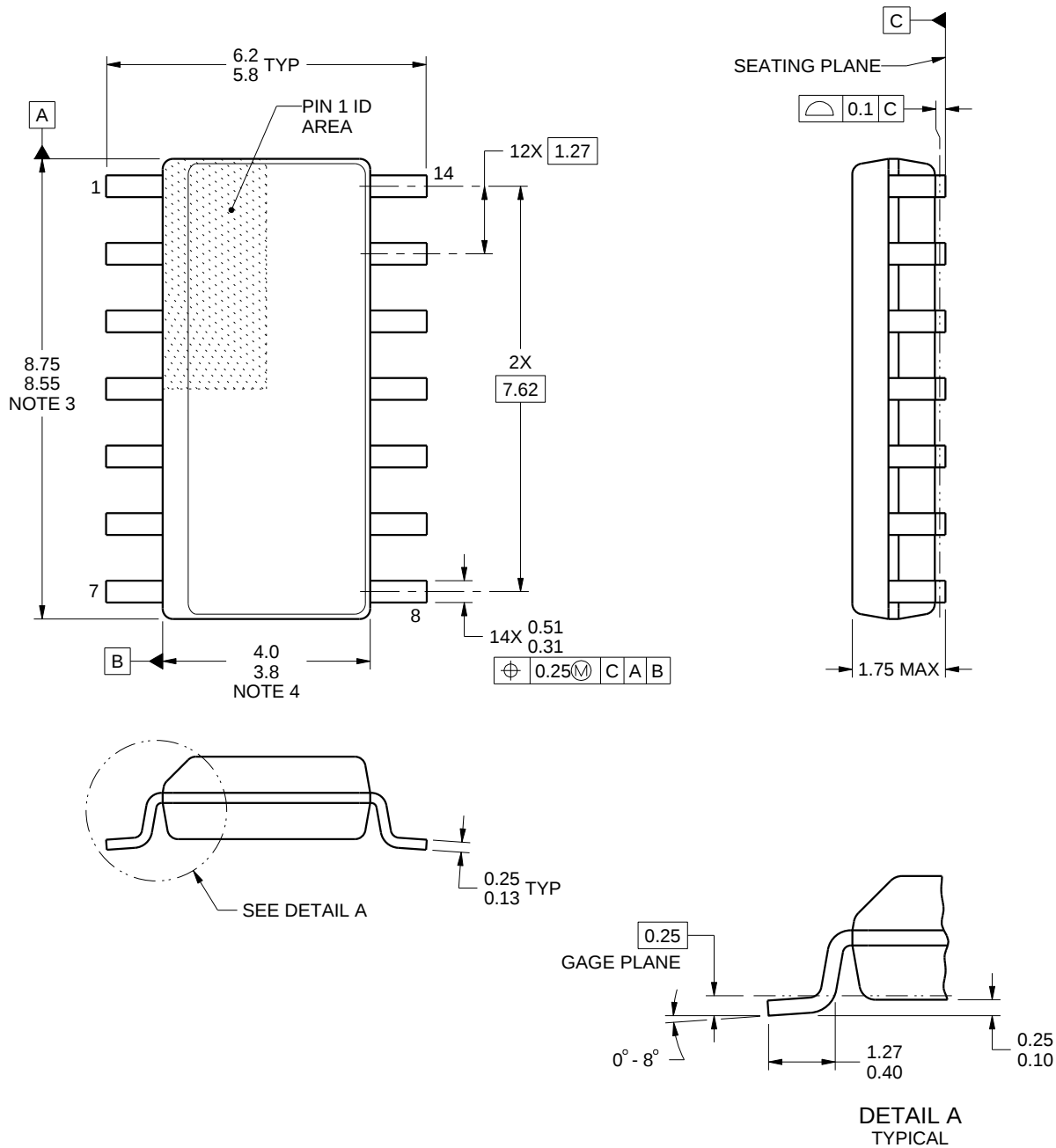
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

**NOTES:**

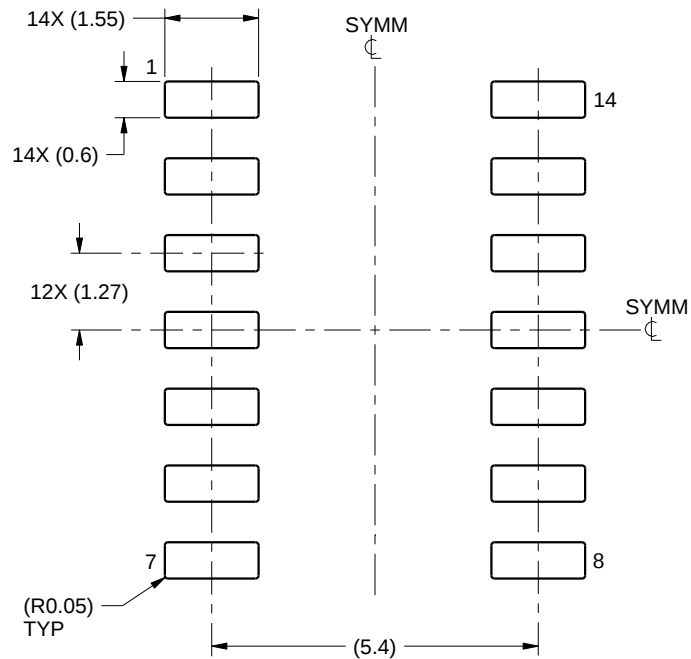
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

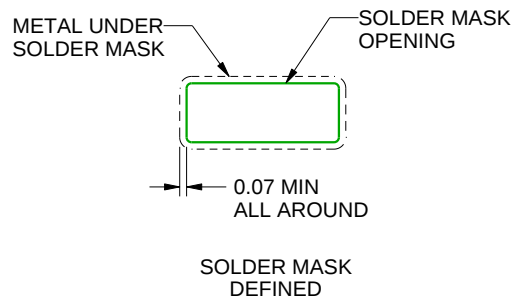
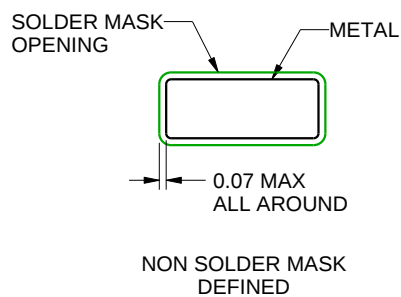
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

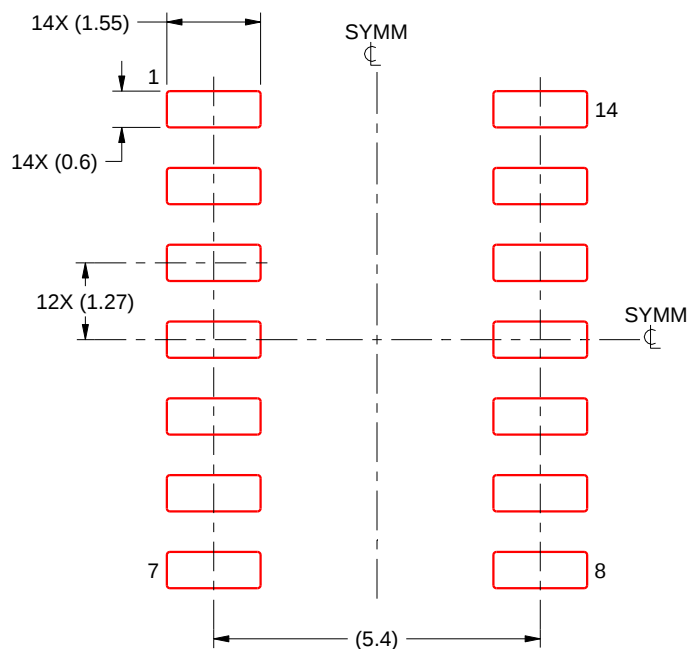
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

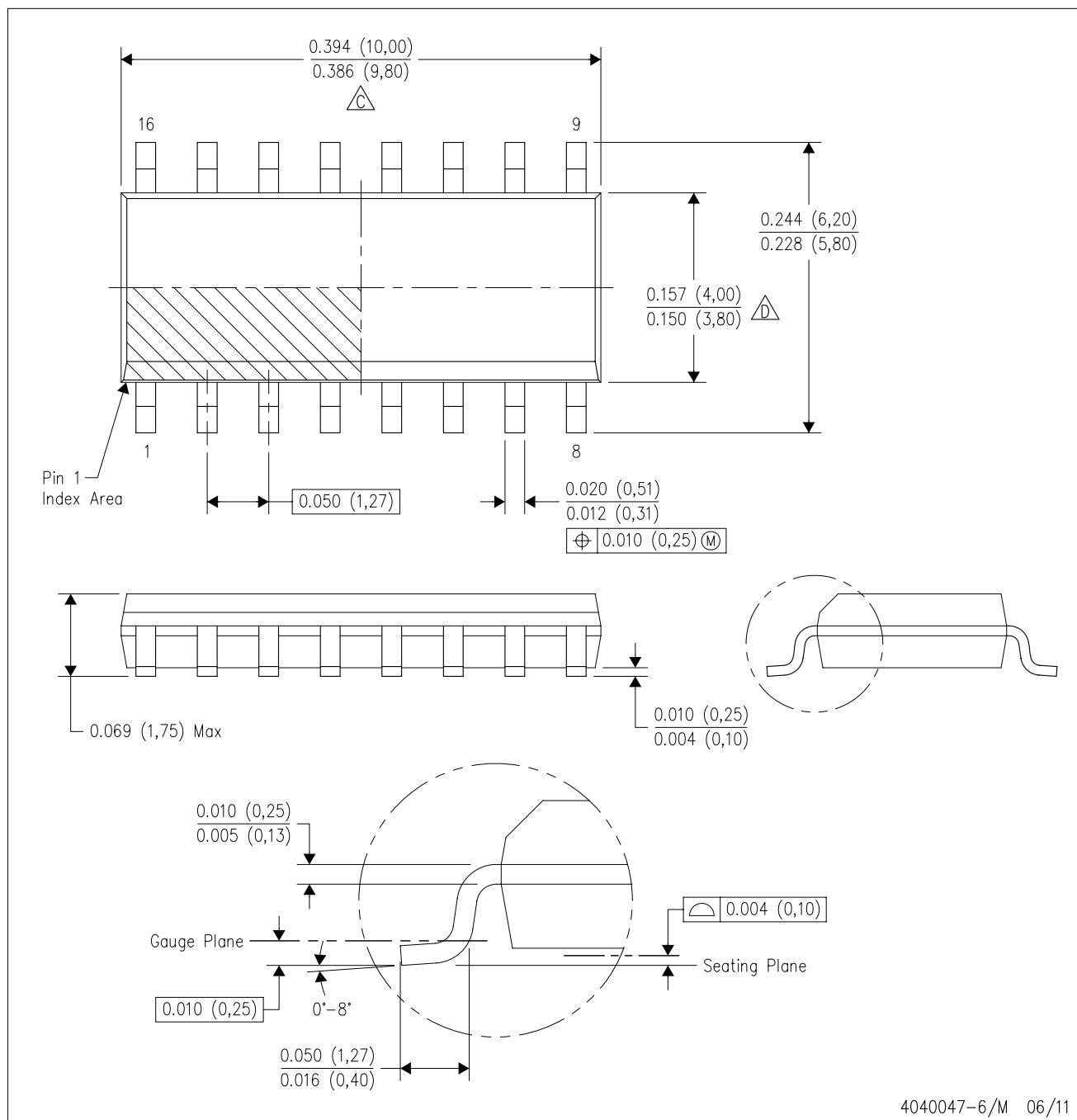
4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

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